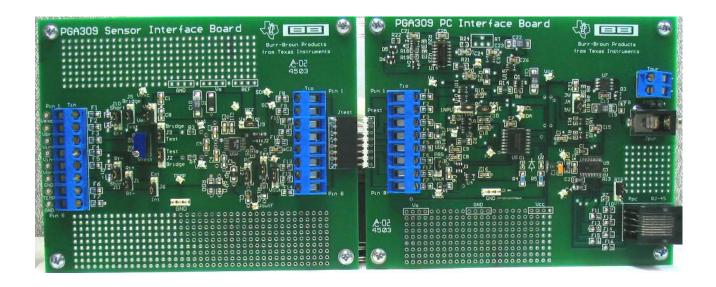


### PGA309EVM User's Guide

SLOR087D - February 2004 - Revised January 2006

## PGA309EVM – Designer's Kit for PGA309



## **COMPLETE EVALUATION TOOL FOR PGA309**

- PGA309 Hardware Designer's Kit
  - Evaluate PGA309 + User's Sensor
  - Full Temperature Evaluation
- Software Control for Designer's Kit
  - Program PGA309 for Evaluation
  - Program PGA309 + User's Sensor in Final Module
  - Computation Analysis Tool for Calibration of PGA309 + Sensor



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#### Note: PGA309 Documentation Availability

Please read and familiarize yourself with the PGA309 Data Sheet and PGA309 User's Guide prior to using the PGA309EVM Designer's Kit since the PGA309 features and modes are not described herein.

Refer to Texas Instruments' Website for latest revision of:

PGA309 Data Sheet and PGA309 User's Guide http://focus.ti.com/docs/prod/folders/print/pga309.html

PGA309EVM User's Guide and PGA309EVM Software http://focus.ti.com/docs/toolsw/folders/print/pga309evm-us.html http://focus.ti.com/docs/toolsw/folders/print/pga309evm-eu.html



#### 1.0 PGA309EVM Parts List (PGA309EVM-US & PGA309EVM-EU)

PGA309 PC Interface Board PGA309 Sensor Interface Board PC Cable (8-position RJ45 Plug to 9-position female DB9) AC Wall Adapter – (*PGA309EVM-US Only USA & Canada Shipments Only*) 120Vac RMS, 60Hz in; 6Vdc, 200mA out PGA309EVM Software CDROM (Rev 1.1.2 or newer) PGA309 Designer's Kit Board Control Software PGA309 Calibration Spreadsheet for Microsoft® Excel PGA309EVM User's Manual

#### 1.1 PGA309 Designer's Kit Board Control Software - Operating System Compatibility

The Board Control Software runs on Win98, Win2000 and WinXP. Also, the regional settings should be set to "English (United States)" with the decimal symbol set to a period. More information on issues related to changing regional settings is given in section 10.3. Consult factory for other operating systems.

#### 1.2 PGA309 Calibration Spreadsheet for Microsoft® Excel - Operating System Compatibility

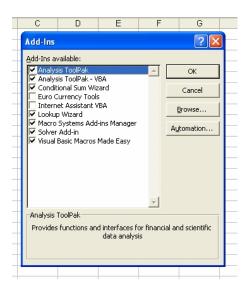
The Calibration Spreadsheet runs on the English version of Microsoft® Excel versions 2000, XP, 2003. Also, the regional settings should be set to "English (United States)" with the decimal symbol set to a period. More information on issues related to changing regional settings is given in section 10.3. Consult factory for other versions.

Ensure that the Excel Analysis Toolpack is enabled. Click on "Tools" and then click on "Add-Ins".

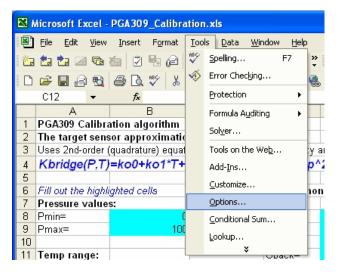
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	A1	-	fx			Protection
	A	В		С		Formula Auditing
1		_				Sol <u>v</u> er
3						Tools on the We <u>b</u>
4						Add-Ins
5						<u>C</u> ustomize
7						Options
8						Conditional Sum
9 10						Lookup
11						*
12						

Ensure that the "Analysis ToolPak" box is checked in the "Add-Ins" pop-up window. Click on "OK" in the "Add-Ins" pop-up window.





In addition you will need to allow Macros to run in Excel. . Click on "Tools" and then click on "Options".



Next select the tab in the "Options" pop-up window. Click on the "Security" tab.



А	BCDEF
9 19	Options ?X
n G	View Calculation Edit General Transition Custom Lists Chart Color International Save Error Checking Spelling Security
t	File encryption settings for this workbook
r	Password to open: Advanced
	File sharing settings for this workbook
	Password to modify:
F	Read-only recommended
	Digital Signatures
-	Privacy options
	<u>Remove personal information from this file on save</u>
Т	Macro security
h	Adjust the security level for files that might contain macro viruses and
	OK Cancel

Click on the "Macro Security" button.





In the "Security" pop-up window, under the "Security Level" tab select either "Low" or "Medium". Click on "OK" in the "Security" pop-up window and also on "OK" in the "Options" pop-up window.

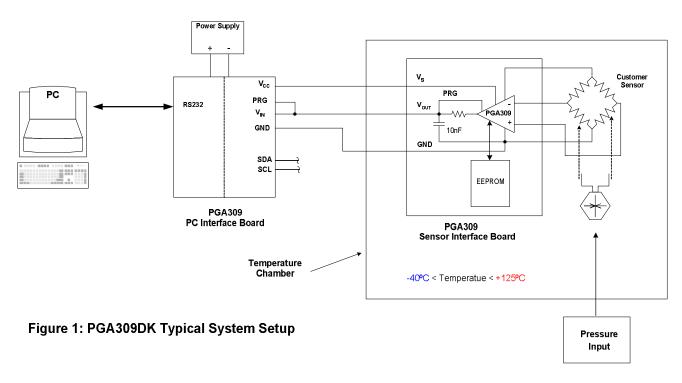
#### 2.0 Description

The PGA309EVM key hardware consists of two boards (see Figure 1), PGA309 Sensor Interface Board and PGA309 PC Interface Board. The PGA309 Sensor Interface Board contains the PGA309, external SOT23-5 EEPROM, and several jumpers for ease of bridge sensor configuration. The PGA309 PC Interface Board contains an RS-232 serial interface, a 3V/5V programmable linear regulator, a switch for power control to the PGA309 Sensor Interface Board, both One-Wire and Two-Wire interface configuration and control logic, and an A/D Converter (ADS1100).

The PGA309EVM is designed to allow the user to attach his sensor to the PGA309 Sensor Interface Board and place this combination in a temperature chamber. By controlling the applied pressure to the pressure sensor and the temperature of the temperature chamber, the PGA309 + Sensor combination can be calibrated for optimum end module accuracy. The PGA309 Sensor Interface Board is rated for operation from -40°C to +125°C. Power, ground, output and digital interface wires connect the PGA309 Sensor Interface Board in the temperature chamber to the external PGA309 PC Interface Board. The PGA309 PC Interface Board communicates to a test computer through a standard RS-232 serial port via the PGA309EVM PC Cable. For USA shipments an AC wall adapter is included to provide 6Vdc to the PGA309 PC Interface Board. For all other applications an alternate connection on the PGA309 PC Interface Board is provided for connection to a 6Vdc (6Vdc-9Vdc) lab supply. The on-board A/D Converter, ADS1100, on the PGA309 PC Interface Board allows for easy reading of the analog output of the PGA309.

The PGA309EVM Software is comprised of two parts. The Board Control Software contains all of the interface and control for communication to the PGA309 through the PGA309 PC Interface Board. It allows for reading and writing to all registers in the PGA309 as well as reading and writing to the external SOT23-5 EEPROM. Both Two-Wire and One-Wire communication options are available. In addition configuration of the PGA309 PC Interface Board and readback of the ADS1100 is provided. The PGA309 Calibration Spreadsheet for Microsoft® Excel provides a useful tool to calculate optimum temperature coefficients for the PGA309 + Sensor calibration based on real-world measurements of pressures at different temperatures. The PGA309 Calibration Spreadsheet also contains Visual Basic for Applications code that allows its integration with the Board Control Software. These macros allow the user to exchange PGA309 settings between the program and the spreadsheet and save the resulting EEPROM configuration file.





#### 3.0 PGA309 Sensor Interface Board Overview

(Refer to PGA309 Sensor Interface Board Schematic)

#### 3.1 Input/Output

Bridge sensor input connections are made though Tin, an 8-position screw terminal strip. In parallel with Tin are plated-through holes that are provided for solder connections if so desired. The connections from the PGA309 Sensor Interface Board to the PGA309 PC Interface Board are provided through Tio, an 8-position screw terminal strip. This connector provides ease of connections to wires for the required selected signals when placing the PGA309 Sensor Interface Board inside a temperature chamber for PGA309 + Sensor calibration. In parallel with Tio is Jtest which provides a means for direct plug-in connection to the PGA309 PC Interface Board. This is useful for initial checkout of the PGA309EVM system.

#### 3.2 Jumper Configuration

J1, J2, J3, J4, J5, J10 and J11 allow flexibility in the configuration of the connection to a bridge sensor. These jumpers also allow connection of the on-board test resistor R<sub>TEST</sub> used for testing functionality of the PGA309 without any bridge sensor connected. Rt+ and Rt- allow for resistors to be used in the top or bottom of the bridge sensor's excitation path for one method of measuring bridge temperature by total bridge resistance changes. Jumper J6 is used to configure the PGA309 circuit for external or internal temperature sensing. If external temperature sensing using an RTD or external diode is to be used then set J6 to EXT and remove the J1 jumper entirely to avoid any interaction with Rt+ or Rt-. J9 provides hardware configuration for either internal or external reference voltage. J8 is used when Vout is to be tied to PRG for a 3-terminal sensor module configuration. J12 and J7 together decide if the Test pin on the PGA309 is to be controlled by the PGA309 PC Interface Board or hardware-programmed on the PGA309 Sensor Interface Board.

#### 3.3 PGA309 + External SOT23-5 EEPROM

U1 is the PGA309 for evaluation. Also on-board is a 16k-bit, external, SOT23-5, industry standard Two-Wire, EEPROM, U2. Although the PGA309 needs only 1k-bit of external EEPROM to access its configuration registers plus the maximum number of 17 temperature coefficients, both the One-Wire and Two-Wire interfaces allow access to locations in much larger EEPROMs which can be used to store user-specific information such as a serial number, lot and date code information, etc.



#### 3.4 Protection and Filtering

The PGA309 Sensor Interface Board is configured with components to prevent mis-wire mishaps. If power is provided from the PGA309 PC Interface Board, D1, is adequate to protect from overvoltages and reverse polarity connections. CL is a standard EMI/RFI capacitor design with Riso and Rp providing up to 16V overvoltage on VoutF. Input common mode plus differential noise filtering is provided by C3, C4, C5 and R3, R4.

#### 3.5 Test Points and Miscellaneous Breadboard Area

There are several Test Points, including a 3-position one for GND, provided for ease of measuring analog signals. Also provided are reserved areas with plated-through, standard-spacing, 0.1" holes for miscellaneous proof-of-concept breadboarding as desired for a given application.

#### 4.0 PGA309 PC Interface Board Overview – Part 1

(Refer to PGA309 PC Interface Board Schematic, Sheet 1 of 2)

#### 4.1 Input/Output

The connections from the PGA309 PC Interface Board to the PGA309 Sensor Interface Board are provided through Tio, an 8-position screw terminal strip. This connector provides ease of connections to wires for the required selected signals when placing the PGA309 Sensor Interface Board inside a temperature chamber for PGA309 + Sensor calibration. In parallel with Tio is Ptest which provides a means for direct plug-in connection to the PGA309 Sensor Interface Board. This is useful for initial checkout of the PGA309EVM system. Ppc is an 8-position RJ45 jack for connection through the PGA309EVM PC cable to a test computer's RS-232 serial port. RS-232 compatible signals are generated through U9. Power for the PGA309 PC Interface Board is provided through either Jpwr or Tpwr. Jpwr is to be used when an AC Wall Adapter (120Vac RMS, 60Hz in; 6Vdc, 200mA out) is available – USA Shipments Only. Other applications will use a 6Vdc (6Vdc-9Vdc) lab supply and the screw terminal inputs on Tpwr. U7 provides a regulated power source of either 3V or 5V, selectable through JA. D3 provides protection from inadvertent reverse polarity connections on Jpwr or Tpwr.

#### 4.2 Port Expander Configuration Control

U5 is an 8-bit serial port expander PCF8574A which allows user control over the configuration of the PGA309 PC Interface Board. D1 and D2 are controlled by the Board Control Software and are used as diagnostic LEDs. Q1, also controlled through U5, provides a mechanism to turn power on and off to the PGA309 Sensor Interface Board by the Board Control Software. This is key when PRG is connected to Vout on the PGA309 since Vout is set to high impedance on power-up for 25ms to allow for One-Wire communication. An unused port, P3, pin 7 is available for customer use with control provided in the Board Control Software. The One-Wire pull-up resistor, R3 can be disabled through U5 to remove loading from the PGA309 Vout pin for an accurate readout through the ADS1100, U3. U5 also controls the zero calibration of the ADS1100. The Two-Wire interface can be isolated from the PGA309 Sensor Interface Board by software through U5 control of U10 and U11 or also by hardware jumper programming.

#### 4.3 One-Wire Digital Interface

On this Designer's Kit the One-Wire digital interface is the preferred mode of communication with PGA309. It is provided through the conversion of RS-232 UART signals from U9 into open drain output through U2. The resistive pull-up for the One-Wire interface is enabled or disabled through U1. The One-Wire pull-up can be disabled for an accurate PGA309 Vout reading without the extra loading due to R3. JC provides a selection for the One-Wire active pull-up (1PU) or no One-Wire active pull-up (1NPU). This feature is described in detail in Section 5.1. Jumper JB provides a mechanism for communication through Vout when PRG is tied to Vout on the PGA309 for a 3-terminal sensor module configuration.



#### 4.4 Two-Wire Digital Interface

Two-Wire digital interface is provided through the conversion of RS-232 signals from U9 into open drain outputs with pull-ups (SDA<sub>OUT</sub> through U6 and SCL<sub>OUT</sub> through U8). SDA<sub>IN</sub> is tied direct to U9 which is looking for <0.8V for a logic low and >2.0V (3V supply) or >2.4V (5V supply) for a logic high. U10 and U11 provide a mechanism, through software or hardware (JE), to separate the Two-Wire bus interface from the PGA309 if it is physically connected. If the PGA309 is in stand-alone mode it will be routinely accessing its external EEPROM via the Two-Wire interface as a master. By disconnecting from the PGA309 Two-Wire connections dedicated, local Two-Wire transactions on the PGA309 PC Interface Board such as reading the ADS1100, U3, can be conducted reliably and without interruption.

# Note: It is recommended to keep One-Wire interface on the PGA309 PC Interface Board connected to the PGA309 Sensor Interface Board even when using Two-Wire communication mode to the PGA309 and EEPROM from the PGA309EVM Board Software. See Section 7.8 for details.

#### 4.5 ADS1100 (On-Board A/D Converter)

The ADS1100 is a 16-Bit A/D available to measure Vout from the PGA309. The ADS1100 is configurable through the Board Control Software. U4 provides a means of measuring the ADS1100 initial offset for improved accuracy in its readings.

#### 4.6 Test Points and Miscellaneous Breadboard Area

There are several Test Points, including a 3-position one for GND, provided for ease of measuring analog signals. Also provided are reserved areas with plated-through, standard-spacing, 0.1" holes for miscellaneous proof-of-concept breadboarding as desired for a given application.

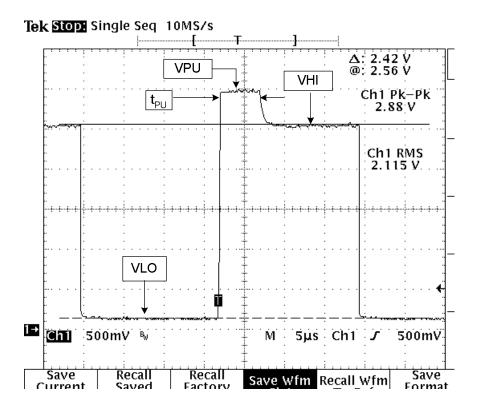
#### 5.0 PGA309 PC Interface Board Overview – Part 2

(Refer to PGA309EVM PC Interface Board Schematic, Sheet 2 of 2)

#### 5.1 One-Wire Active Pull-Up

The One-Wire Active Pull-Up circuitry is intended to provide a fast rising edge pull-up when the One-Wire interface is connected to heavy capacitive loads such as when PRG is tied to Vout on the PGA309 and there is a 10nF capacitor on Vout to GND. In this configuration there is an extremely long rise time due to a  $4.7k\Omega$  pull-up on the One-Wire interface. One-Shot U14 is rising edge triggered only, non-retriggerable. Comparator U12 looks for a rising edge to transition above 0.7V. The One-Shot, U14, then triggers and produces a 5µS wide pulse which controls switch U13. When switch U13 is turned on a 200 $\Omega$  pull-up to V<sub>S</sub> is provided on the One-Wire Interface. At the end of the 5µS pulse the 200 $\Omega$  pull-up to V<sub>S</sub> is removed. The 5µS was chosen to provide a near-symmetrical rise and fall time into a 10nF load on the One-Wire interface. RT is a provisional potentiometer which can be added to change the time the active pull-up is applied to the One-Wire Interface. D5, D6 and R22 proved a clamp to keep the input of U12 inside its allowed input voltage range for reliable operation. Figure 2 illustrates the One-Wire Pull-Up into a non-capacitive load. The table shows typical values for a supply voltage of 3.0V.





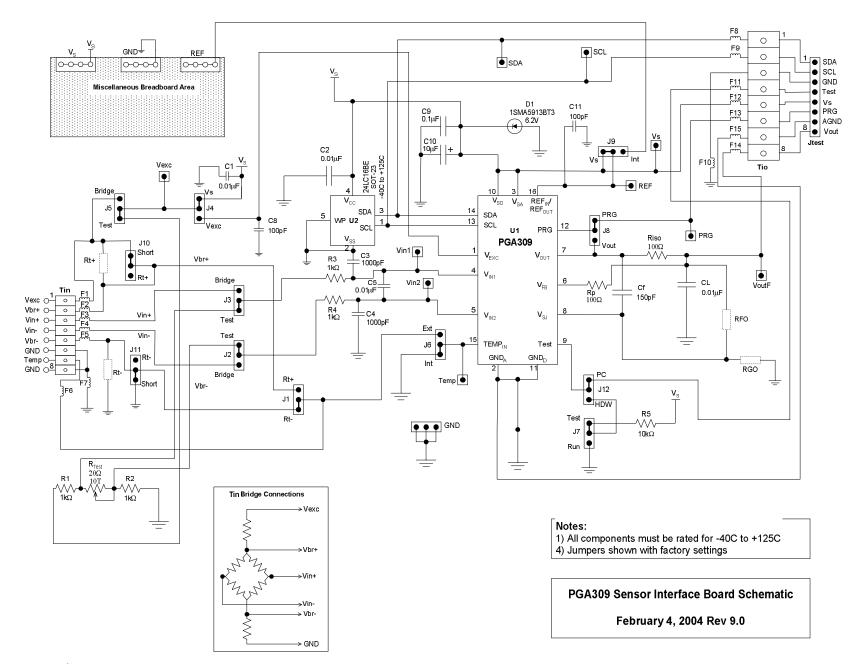
Parameter	Typical
VPU	3.0V
VHI	2.63V
VLO	122mV
t <sub>PU</sub>	5µs

Figure 2: One-Wire Active Pull-Up Waveform and Typical Levels (V<sub>s</sub>=3V)

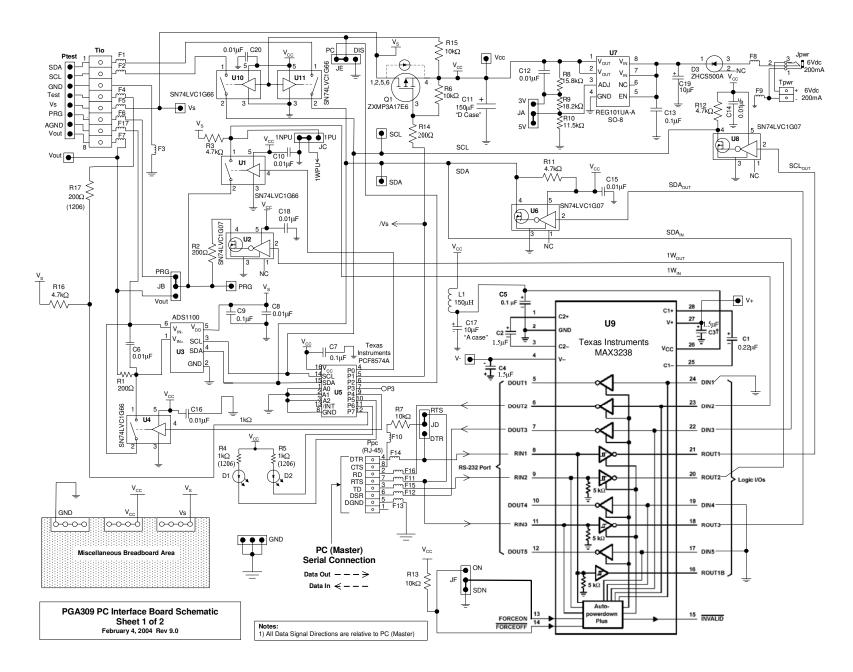
#### 5.2 V<sub>s</sub> Quick Discharge

It is desired at times to cycle the power on the PGA309 to be able to communicate through PRG, when it is tied to Vout, while Vout is set to high impedance by the PGA309 on initial power-up. The supply voltage on the PGA309 must decay to near zero to ensure that on power-up the state of the PGA309 is set correctly. With a 10µF capacitor on Vs on the PGA309 PC Interface Board and another 10µF capacitor on Vs on the PGA309 Sensor Interface Board reliable reset operation is guaranteed by discharging these capacitors through U15 and R25. Whenever Q1 (see Sheet 1 of 2 - PGA309 PC Interface Board Schematic) is off and disconnects power from Vs then U15 is on for quick discharge of Vs. And whenever Q1 is on then U15 is off.

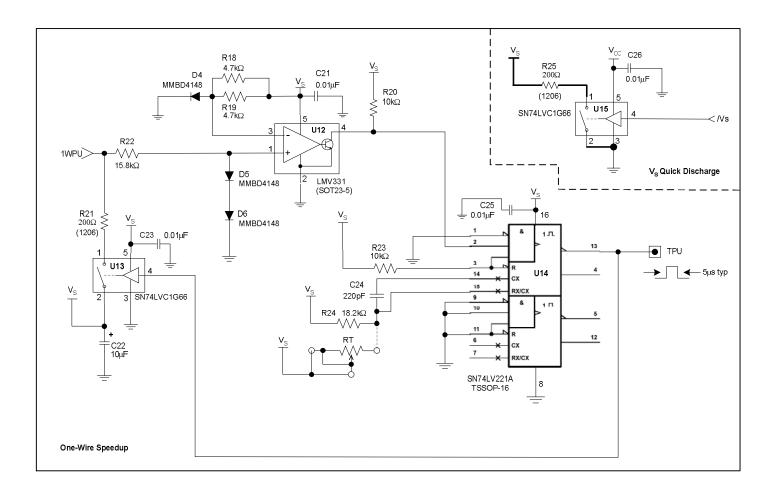




Burr-Brown Products from Texas Instruments







PGA309 PC Interface Board Schematic Sheet 2 of 2



#### 6.0 Initial Setup and Checkout

#### 6.1 PGA309 Sensor Interface Board – Factory Jumper Settings

Confirm and/or set the jumpers on the PGA309 Sensor Interface Board as shown in Figure 3. The desired jumper settings are also described in Table 1.

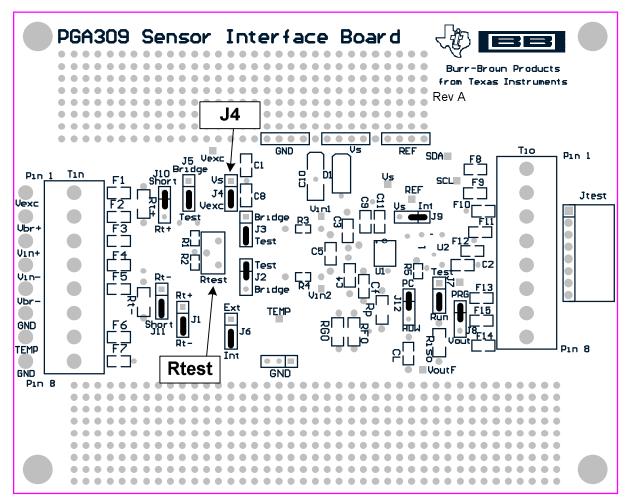


Figure 3: PGA309 Sensor Interface Board – Factory Jumper Settings

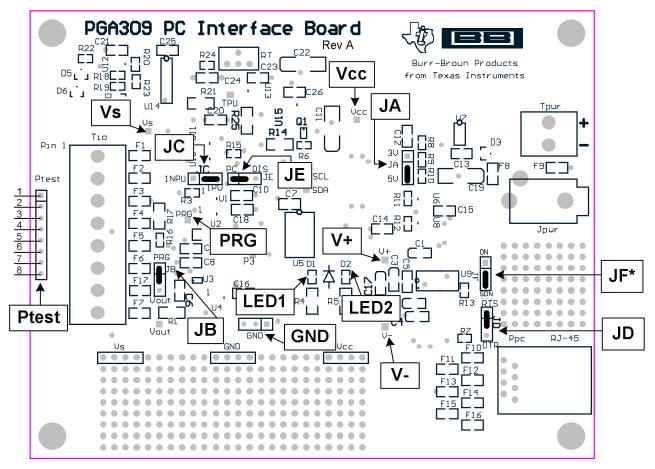
PGA309 Senso	r Interface Board – Factory	Jumper Settings
Jumper	Position	
J1	Rt-	Use on-board pot for bridge
J2	TEST	Use on-board pot for bridge
J3	TEST	Use on-board pot for bridge
J4	VEXC	Use PGA309 Vexc
J5	TEST	Use on-board pot for bridge
J6	INT	Use on-chip temp sensor
J7	RUN	Use EEPROM for settings
J8	PRG	PRG not connected to VOUT
J9	INT	Internal Reference
J10	SHORT	Use on-board pot for bridge
J11	SHORT	Use on-board pot for bridge
J12	PC	PC Interface Board control for Test Mode

Table 1: PGA309 Sensor Interface Board – Factory Jumper Settings



#### 6.2 PGA309 PC Interface Board – Factory Jumper Settings

Confirm and/or set the jumpers on the PGA309 PC Interface Board as shown in Figure 4. The desired jumper settings are also described in Table 2.



\*Rev A Boards Only

Figure 4: PGA309 PC Interface Board – Factory Jumper Settings

PGA309 PC In	terface Board – Facto	ory Jumper Settings
Jumper	Position	
JA	5V	PGA309 operates at +5V
JB	PRG	PRG not connected to VOUT
JC	1PU	Dynamic One-Wire Pullup Enabled
JD	RTS	PC Serial Interface loopback set for CTS-RTS
JE	PC	Two-Wire Enable Control by PC
JF*	SDN	RS-232 Auto Shutdown Mode

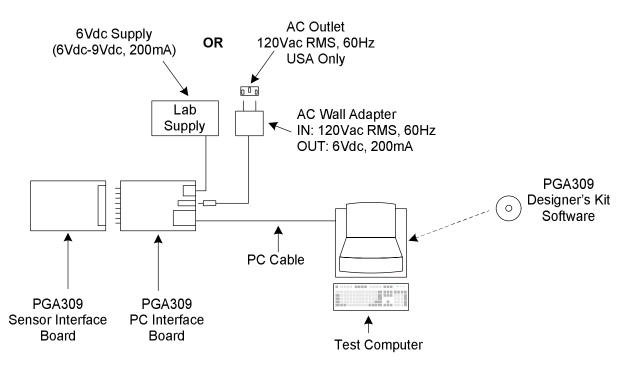
\*Rev A Boards Only

#### Table 2: PGA309 PC Interface Board – Factory Jumper Settings



#### 6.3 Hardware Setup (see Figure 5)

Plug the PGA309 Sensor Interface Board into the PGA309 PC Interface Board. On the PGA309 PC Interface Board connect a 6Vdc (6Vdc-9Vdc) Lab Supply into Tpwr or an AC Wall Adapter (120Vac RMS, 60Hz in; 6Vdc, 200mA out - USA Shipments Only) into Jpwr. Connect the PGA309EVM PC Cable from Ppc (RJ-45 jack) on the PGA309 PC Interface Board to an RS-232 serial port on the Test Computer.



#### Figure 5: Hardware Setup – Initial Checkout

#### 6.4 Board Control Software Installation

- 1) The PGA309EVM Board Control Software is installed in the normal Microsoft® Windows manner. Close all other applications. From "Start" button on the task-bar select "Run".
- 2) In the Run Window type:

d:\setup

where "d" is the letter designation of the CD-ROM drive containing the PGA309EVM Software CD-ROM.

- 3) Follow the on-screen prompts to install the software.
- 4) To remove the PGA309EVM application use the Windows Control Panel utility "Add/Remove Software".

#### 6.5 Software/Hardware Initial Checkout

At this point no LEDs should be lit on the PGA309 PC Interface Board. If any LEDs are lit cycle the power on the PGA309 PC Interface Board.



#### 6.5.1 Software Startup

Start the PGA309EVM Board Control Software by clicking on "PGA309 DK Board Interface" under the "Start" menu, "All Programs", "PGA309 Designer's Kit" as shown in Figure 6.

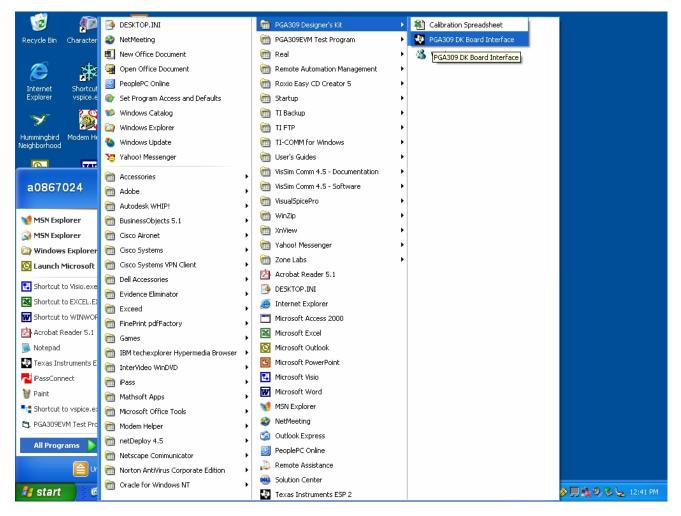


Figure 6: PGA309EVM Board Control Software Startup



#### 6.5.2 Software Board Communication Setup – Default

On initial software startup a Main Window will appear with a smaller pop-up window in the middle of the Main Window. Click "Yes" on the pop-up window (see Figure 7). If the initial software startup does not look like Figure 7 then proceed directly to Section 6.5.3.

😻 Texas I	Instruments PG	A309 Desig	ner's Kit Contro	ol Program	1				
File Edit	Board Setup								
C Reset	Open File	Save File	Detect	Write PGA30	09 Read PGA309	Write	EPROM Read EE	PROM Set PreCal EE	
- PGA309 F	shorted to Vout   Registers e register to edit the v		9 Test Pin HIGH the details Binary		- <b>PGA Settings</b> Coarse Offset (mV) FrontEnd PGA Gair Zero DAC (V):		0.000 <b>•</b> 4.000 <b>•</b> 0.000	Enable Internal Vref: Vref Value : <b>5.0</b> Fault Detection	
0000 0001 0010 0011 0100 0101 0101 0110	ADC Out(RO) ZeroDAC GainDAC * Ref&Lin * Gain,Vos,Cfg1 * Cfg2,OverUnder * Cfg3 (ADC)	0x0000 0 0x0000 0 0x0000 0 0x0000 0 0x0000 0 0x0000 0	)x0000_0000_0000 )x0000_0000_0000 )x0000_0000_0000 )x0000_0000_0000 )x0000_0000_0000 )x0000_0000_0000 )x0000_0000_0000	 D0000 D0000 D0000 D0000	Gain DAC (V/V): Output Amp Gain ( Enable Over/Unde Oversca Underscal	er-Scale Ile Limit :		Detect External Faults Detect Internal Satura Vout high on external I Vout high on internal f PGA309 Temp ADC DegC Dec 0	tion: 🔽
0111 1000	OutEnbl Counter AlarmStatus(RO) Config Checksum	PGA309			rs to be connected. DM and register con	tents int	o the PC memory?	Convert	ADC Config
ZFFF	0000 8000		[	Yes	No	>	Decimal C Apply Changes Discard Changes Show 1kBit EEPROM	Supply Vcc (V): Volt 0 Dec 0 Hex 0 Update Vout Keep comm alive Instant Update Autocalc Chksum Update Checksums	5.0 Board Settings PGA Interface Iwo-Wire C Dine-Wire C COM Port Setup
EEPROM L	ookup Table Bit	nap of a reg	ister						
Detecting PG	GA309 board. Please	stand by.							

Figure 7: Software Startup – Main Window and First Pop-up Window



The First Pop-Up Window will disappear and the Main Window should look as in Figure 8. If it does then proceed to Section 6.5.4 and skip Section 6.5.3.

<u> </u>	Board Setup			的					
Reset		Save File			09 Read PGA309 M - PGA Settings	vrite Et	EPROM   Read EE	PROM Set PreCal EE	
•	n shorted to Yout	PGA3	309 Test Pin HIG	н 🗆 🛛	Coarse Offset (mV) :	[-	-3.482m 🔻	Enable Internal Vref: 🖡	~
	I Registers he register to edit the va		- 4		FrontEnd PGA Gain (V	///): [	54.000 -	Vref Value : 4.096	·
Addr	Name	Hex	Binary		Zero DAC (V):	1	319.000m	Fault Detection	
0000	ADC Out(RO)	0x3078	0x0011 0000 011	1 1000				Detect External Faults	
0001	ZeroDAC	0x13F0	0x0001 0011 111		Gain DAC (V/V):	1	27.549m	Detect Internal Satura Vout high on external	
0010	GainDAC	0x9761	0x1001_0111_011		Output Amp Gain (VA	V): 🛛	2.400 🔻	Vout high on internal f	
0011	* Ref&Lin	0x0500	0x0000_0101_000	0_000	Enable Over/Under-S			- PGA309 Temp ADC-	
0100	* Gain, Vos, Cfg1	0x1611	0x0001_0110_000	1_0001	Overscale L	Limit : 🔤	3.976 👻	DegC 775.5 degC	
0101	* Cfg2,OverUnder	0x0A47	0x0000_1010_010		Underscale L	.imit : 🗗	247.808m 🔻	Dec 12408	
0110	* Cfg3 (ADC)	0x1603	0x0001_0110_000		Enable Sensor Excita		∠47.000m <u>·</u>		
0111	OutEnbl Counter	0x0000	0x0000_0000_000			exc:		Hex 3078 h	ADC Config
000	AlarmStatus(RO) Config Checksum	0x0000 0x705B	0x0000_0000_000 0x0111 0000 010		Linearization Coef (VA		3.400	Convert	
.ookup	Table							- Interface Board ar	
0800	0640 FFFF					~ [	Display Mode		
7FFF	0000 71C1						Binary C	Supply Vcc (V):	5.0
							Hex 💿 🗌 Decimal 🔿	Volt 3.03940	
							Decimal C	Dec 19919	Ser.
							Apply		
							Apply Changes	Hex 4DCF	Board
							Changes Discard	Hex 4DCF Update Vout	Board Settings
							Changes		Settings
							Changes Discard	Update Vout	
							Changes Discard	Update Vout Keep comm alive Instant Update	Settings PGA Interfac <u>I</u> wo-Wire
							Changes Discard	Update Vout	Settings PGA Interfac

Figure 8: Software Startup – Main Window

#### 6.5.3 Software Board Communication Setup – Manual COM Port Setup

If on initial software startup the right Com port is not selected automatically then the first screen will look like Figure 9. If you are getting a different error, your problem could be related to regional settings. More information on regional settings is given in section 10.3.

			A309 Desi	gner's Kit Contro	ol Progran	n				
le Edit	Board S	etup								
C) Reset		an File	Save File	Detect	Write PGA3	809 Read PGA309	Write	EEPROM Read EE	PROM Set PreCal EE	
PBG nir	n shorted I	to Vout	PGA3	09 Test Pin HIGH		PGA Settings				
•						Coarse Offset (mV)	:	-3.482m 🔻	Enable Internal Vref:	<b>Z</b>
	Registers		alue and se	a tha dataila		FrontEnd PGA Gair	n (V/V) :	64.000 -	Vref Value : 4.096	r
						Zero DAC (V):		319.000m	Fault Detection	
ddr	Na		Hex	Binary	4000			319.00011	Detect External Fault	
000	ADC 0		0x3078	0x0011_0000_0111		Gain DAC (V/V):		727.549m	Detect Internal Satur	
001	Zero		0x13F0	0x0001_0011_1111		Output Amp Gain N	WN:	2.400 🔻	Vout high on external	
	Gain		0x9761	0x1001_0111_0110					Vout high on internal	fault:
011	* Ret		0x0500	0x0000_0101_0000		Enable Over/Unde Overscal			- PGA309 Temp ADC-	
100	* Gain,V		0x1611 0x0A47	0x0001_0110_0001					DegC 775.5 degC	
101 110	* Cfg2,0 * Cfg3	verUnder	0x0A47 0x1603	0x0000_1010_0100 0x0001_0110_0000		Underscal	e Limit :	247.808m 🔻	Dec 12408	
110	-	(ADC) Counter	0x1603	0x0001_0110_0000		Enable Sensor Exc		,	Hex <b>3078 h</b>	
000			Error		10000	X	Vexc:		Hex Juron	ADC Config
000		hecksum	EITOF					0.100	Convert	
	coning c	necksum				arization Coef (	(V/V):	0.000		
ookup	Table —			The PGA309 Board is	not respon	ding			-Interface Board a	nd ADS1100
0080	0640	FFFF					~	Display Mode		
FFF	0000	7101		ОК				Binary 🔿	Supply Vec (V):	5.0
								Hex 📀	Volt 3.03940	
								Decimal O	Dec 19919	= 💕
								Apply		
								Changes	Hex 4DCF	
								Discort	Update Vout	Board Settings
								Discard Changes	opuate vour	Jettinga
								onangoo		– PGA Interfa
									Keep comm alive 🦳	
									Instant Update 🔲	<u>T</u> wo-Wire
								1	Autocalc Chksum 🔽	<u>0</u> ne-Wire
								Show 1kBit	Autocale Criksum JV	
							$\sim$	EEPROM	Update	COM Port
									Checksums	Setup
		<b>R</b> :4		rinter						
PROM	Lookup Ta	able Bitr	map of a re	gister						
ecting F	PGA309 boa	ard. Please	stand by.							

#### Figure 9: Software Startup – Wrong Com Port

Click on "OK" in the pop-up window in Figure 9. Then click on "COM Port Setup" in the Main Window. A new pop-up window will appear as in Figure 10. Select the serial port where the board is connected and desired Baud Rate and click "OK". Ensure "<u>1</u>Wire" Interface is selected.

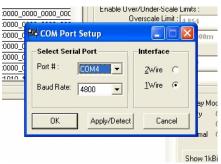


Figure 10: COM Port Pop-up Window



Another pop-up window will appear as shown in Figure 11. Click "Yes" and the two pop-up windows should disappear with only the Main Window remaining as in Figure 8.

D	🚅		<b>III</b>	604					
Reset		Save File	Detect		309 Read PGA309	Write EEPR	OM Read E	EPROM Set PreCal EE	
PBG nir	n shorted to Yout	PGA3	09 Test Pin HIG	нг	PGA Settings				
	Registers			,	Coarse Offset (mV) :	1-2-0	82m 🔻	Enable Internal Vref: 🔽	7
	he register to edit the v	alue and see	e the details		FrontEnd PGA Gain	(V/V): 64.0	• 000	Vref Value : 4.096 💌	]
Addr	Name	Hex	Binary		Zero DAC (V):	319	.000m	Fault Detection Detect External Faults:	: F
0000	ADC Out(RO)	0x3078	0x0011_0000_01	11_1000	Gain DAC (V/V):	727	.549m	Detect Internal Satural	
0001	ZeroDAC	0x13F0	0x0001_0011_11	11_0000				Vout high on external f	
0010	GainDAC	0x9761	0x1001_0111_01	10_0001	Output Amp Gain (V	<sup>(/V]</sup> : 2.40	• •	Vout high on internal fa	ault: j
0011	* Ref&Lin	0x0500	0x0000_0101_00		Enable Over/Under			PGA309 Temp ADC-	
0100	* Gain, Vos, Cfg1	0x1611	0x0001_0110_00			e Limit : 🖪 🧿	76 <b>-</b>	DegC 775.5 degC	
0101	* Cfg2, OverUnder	0x0A47	0x0000_1 104 CO	OM Port Set	tup 🚺		08m 🔻	Dec 12408	
0110	* Cfg3 (ADC)	0x1603	0x0001 0					000 12400	
						·	E I		
0111	OutEnbl Counter	0x0000		lect Serial P	Port - Inter	face	<b>v</b>	Hex 3078 h	ADC Config
0111 1000		0x0000		lect Serial P	Port Inter(	face	V V	Hex 3078 h Convert	ADC Config
	OutEnbl Counter PGA309 Designe	oxoooo er's Kit	oxoooo o c Sel		Port   Inter	$\times$			ADC Config
	PGA309 Designe	oxoooo er's Kit nterface Bo	ard appears to be	connected.	Port Interd	× _			
1000 Lookup 0800	PGA309 Designe	oxoooo er's Kit nterface Bo	ard appears to be	connected.		× _		Convert	d ADS110
1000 Lookup	PGA309 Designe	oxoooo er's Kit nterface Bo	ard appears to be	connected.		× •	ay Mode	Convert Interface Board an Supply Vcc (V):	
1000 Lookup 0800	PGA309 Designe	oxoooo er's Kit nterface Bo	ard appears to be the EEPROM and r	connected. register conter		× _	ay Mode	Convert	d ADS110
1000 Lookup 0800	PGA309 Designe	oxoooo er's Kit nterface Bo	ard appears to be the EEPROM and r	connected. register conter		× •	ay Mode	Convert Interface Board an Supply Vcc (V):	d ADS110
1000 Lookup 0800	PGA309 Designe	oxoooo er's Kit nterface Bo	ard appears to be the EEPROM and r	connected. register conter		v?	ay Mode y C mal C	Convert Interface Board an Supply Vcc (V): Volt 3.03940 Dec 19919	d ADS110
1000 Lookup 0800	PGA309 Designe	oxoooo er's Kit nterface Bo	ard appears to be the EEPROM and r	connected. register conter		v?	ay Mode y C mai C	Convert Interface Board an Supply Vcc (V): Volt 3.03940	d ADS110
1000 Lookup 0800	PGA309 Designe	oxoooo er's Kit nterface Bo	ard appears to be the EEPROM and r	connected. register conter		y?	ay Mode y C mal C Apply hanges	Convert Interface Board an Supply Vcc (V): Volt 3.03940 Dec 19919	d ADS110
1000 Lookup 0800	PGA309 Designe	oxoooo er's Kit nterface Bo	ard appears to be the EEPROM and r	connected. register conter		y?	ay Mode y C mal C Apply hanges	Convert Interface Board an Supply Vcc (V): Volt 3.03940 Dec 19919 Hex 4DCF	d ADS110 5.0 Board Settings
1000 Lookup 0800	PGA309 Designe	oxoooo er's Kit nterface Bo	ard appears to be the EEPROM and r	connected. register conter		y?	ay Mode y C mal C Apply hanges	Convert Interface Board an Supply Vcc (V): Volt 3.03940 Dec 19919 Hex 4DCF	d ADS110 5.0 Board Settings
1000 Lookup 0800	PGA309 Designe	oxoooo er's Kit nterface Bo	ard appears to be the EEPROM and r	connected. register conter		y?	ay Mode y C mal C Apply hanges	Convert Interface Board an Supply Vcc (V): Volt 3.03940 Dec 19919 Hex 4DCF Update Vout Keep comm alive	d ADS110
1000 Lookup 0800	PGA309 Designe	oxoooo er's Kit nterface Bo	ard appears to be the EEPROM and r	connected. register conter		y?	ay Mode y C mal C Apply hanges	Convert Convert Interface Board an Supply Vcc (V): Volt 3.03940 Dec 19919 Hex 4DCF Update Vout Keep comm alive Instant Update	d ADS110 5.0 Board Settings PGA Interfa Iwo-Wire
1000 Lookup 0800	PGA309 Designe	oxoooo er's Kit nterface Bo	ard appears to be the EEPROM and r	connected. register conter		y? c zel C c c c c c c c c c c c c c	ay Mode y C mal C Apply hanges	Convert Interface Board an Supply Vcc (V): Volt 3.03940 Dec 19919 Hex 4DCF Update Vout Keep comm alive	d ADS1100
1000 Lookup 0800	PGA309 Designe	oxoooo er's Kit nterface Bo	ard appears to be the EEPROM and r	connected. register conter		y? c zel C c c c c c c c c c c c c c	Apply hanges	Convert Convert Interface Board an Supply Vcc (V): Volt 3.03940 Dec 19919 Hex 4DCF Update Vout Keep comm alive Instant Update	d ADS110

Figure 11: Communication Pop-up Window after COM Port Setup

#### 6.5.4 Hardware Checkout

1) In the Main Window click on "Open File". A pop-up window will appear as in Figure 12.

G	Open					? 🗙
k	Look in:	C PGA309 Des	igner's Kit	•	← 🗈 💣 📰•	
14101011111101011110101	📁 Recent	PGA309_DK_T	est.txt			
101011	Desktop					
	My Documents					
	My Computer					
		File name:	PGA309_DK_Test.txt		•	Open
	My Network	Files of type:	Text (*.txt)		•	Cancel
	Places		Copen as read-only			

Figure 12: Open File Pop-up Window



- 2) Select "PGA309\_DK\_Test.txt" and open this file
  - (located in the PGA309EVM Software directory typically C:\Program Files\PGA309 Designer's Kit). A pop-up window will appear as in Figure 13. Click on "OK".

PGA309 Designer's Kit
The file C:\Program Files\PGA309 Designer's Kit\PGA309_DK_Test.txt has been succesfully loaded
OK

#### Figure 13: Open File Acknowledge Pop-up Window

The Main window will appear as in Figure 14.

<u>E</u> dit	s Instruments PGA Board Setup		Sher o hie cons				
C Reset	t Open File	Save File	Detect	Write PGA30		Write EEPROM R	ead EEPROM Set PreCal EE
GA309	n shorted to Vout 9 Registers the register to edit the va Name		e the details Binary	•	PGA Settings Coarse Offset (mV) : FrontEnd PGA Gain ( Zero DAC (V):	-3.482m	Enable Internal Vref:      Vref Value : 4.096     Fault Detection
000 001 010 011 100 101	ADC Out(RO) ZeroDAC GainDAC * Ref&Lin * Gain,Vos,Cfg1 * Cfg2,OverUnder	0x0186 0x0640 0xFFFF 0x0500 0x1611 0x0A47	0x0000_0001_100 0x0000_0110_0100 0x1111_1111_	0_0000 1_1111 0_0000 1_0001 0_0111		(): 2.400	Detect External Faults:     Detect Internal Saturation:     Vout high on external fault:     Vout high on internal fault:     PGA309 Temp ADC     DegC 24.375 degC     Dec 390
110 111 000	* Cfg3 (ADC) OutEnbl Counter AlarmStatus(RO) Config Checksum	0x1603 0x0000 0x0000 0x705B	0x0001_0110_000 0x0000_0000_000 0x0000_0000_	0_0000	Enable Sensor Excita	ation : /exc: 3.400	Hex 196 h ADC Cor Convert
)800 7FFF	0640 FFFF 0000 71C1					Hex	de Supply Voc (V): 5.0 Volt 0.73257 Dec 4801 Hex 12C1 Update Vout Setting
						Show 1kB	Update COM F
							Checksums Setu

Figure 14: Main Window After Open File = "PGA309\_DK\_Test.txt"



Table 3 details the PGA309 settings defined by this file (PGA309\_DK\_Test.txt).

Parameter	Desired Setting	Comments
V <sub>DIFF</sub>	0V to 33.67mV	Adjust $R_{TEST}$ from $0\Omega$ to $20\Omega$
V <sub>REF</sub>	4.096V	Use Internal PGA309 Reference
V <sub>EXC</sub>	3.4V	Use Linearization Circuit, Range 0
		(K <sub>EXC</sub> =0.83), LinDAC=0
Coarse Offset	-3.277mV	
Front End PGA Gain	64	
Gain DAC	1	
Output Amplifier Gain	2.4	
Zero DAC	100mV	
Over-Scale	3.976V	
Under-Scale	0.245V	
V <sub>OUT</sub> Ideal	-0.263V to +4.908V	With Over-Scale and Under-Scale disabled
V <sub>OUT</sub> Final (Ideal)	0.245V to 3.976V	With Over-Scale and Under-Scale enabled
Fault Detection	External Comparators	Enable
	Fault Detect Polarity	Positive
	Internal Comparators	Disable
Temperature ADC	Internal Mode	Continuous Conversion Mode
Output Enable Counter	Set to all zeroes	
EEPROM Temperature		Set so all temperatures $\leq +128$ °C will use
Coefficients		same Gain DAC and Zero DAC settings

#### Table 3: PGA309EVM Sensor Interface Board Functional Test Settings

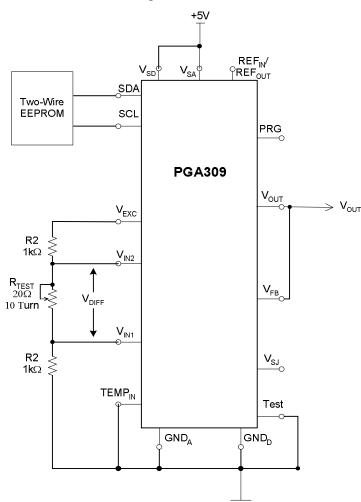
#### Equations for Table 3:

V<sub>OUT</sub> = V<sub>DIFF</sub> (Front End PGA Gain)(Gain DAC)(Output Amplifier Gain) + Coarse Offset (Front End PGA Gain)(Gain DAC)(Output Amplifier Gain) + Zero DAC (Gain DAC)(Output Amplifier Gain)

 $\begin{array}{rll} V_{\text{OUT}} &=& V_{\text{DIFF}} \ (64)(1)(2.4) \ + \\ && -3.277 mV \ (64)(1)(2.4) \ + \\ && 100 mV \ (1)(2.4) \end{array} \\ V_{\text{OUT}} &=& V_{\text{DIFF}} \ (153.6) \ - \ 0.2633V \end{array}$ 



Schematic for PGA309 Configuration in Table3:



- 3) Write these settings to the PGA309 Sensor Interface Board EEPROM by clicking on "Write EEPROM" in the Main Window. Click on "Read EEPROM" and then click on "Read PGA309". The Main Window should look the same as in Figure 14.
- 4) Configure ADS1100 for continuous readback. In the Main Window click on "Board Settings". The Status Window ("ADS1100 and PCF8574A Status" Window) will appear as in Figure 15.



	😻 TI PGA309 Interface Board (ADS1100 and P	CF8574A Status)		
Rese	- OutputVoltage/Ref Set			M
PRG pi				able Internal Vref: 🔽
PGA30: Click on	Volt 4.91318 Vs = 5.0	Single Shot	Calibrate ADS1100	ef Value 4.096 💌
Addr	Hex 7DC7	- Read ADS1100		ault Detection
0000	Decimal 32199 Read ADS1100	Continuously	Gen Call Reset	Detect External Faults:
0001				√out high on external fault: 🔽
0010	ADS Output Register			√out high on internal fault: □
0100	D15 D14 D13 D12 D11 D10 D9 D8	D7 D6 D5 D4	D3 D2 D1 D0	PGA309 Temp ADC begC 25.6875 degC
0101	0 1 1 1 1 1 0 1	1 1 0 0	0 1 1 1	bec 411
0110	MSB		LSB	ley 19B b
1000	ADS1100 Configuration/Status Register	EVM (PCF8574A)		Convert ADC Config
	Abs rive configuration/status register	Test ADS1	110	
Looku	OS D6 D5 SC R1 R0 G1 G0	pin nLED2 nLED1 Ca		nterface Board and ADS1100
0800 7FFF				Supply Vcc (V): 5.0
////	MSB LSB	MSB	LSB	
-			Coomina /	Dec 32199
			Apply	Hex 7DC7
			Changes	Board
			Discard Changes	Update Vout Settings
				Keep comm alive
				Instant Update
			(h	Autocalc Chksum
			Show 1kBit EEPROM	
1				Update COM Port Checksums Setup

#### Figure 15: Status Window

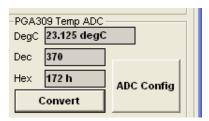
- 5) In the Status Window check the box to "Read ADS1100 Continuously".
- 6) In the Main Window set "Supply Vcc (V)" to 5.0V
- 7) The "Rtest" potentiometer and "J4" on the PGA309 Sensor Interface Board will be used for this test. On the PGA309 PC Interface Board the ADS1100 ADC will be used for this test. Table 4 below details the actions and acceptable results for a pass condition of the PGA309 Sensor Interface and PGA309 PC Interface Boards.

Step	Rtest	J4	ADS1100 read	ADS1100 read
		Position	(Volts min)	(Volts max)
1	Rotate Fully Clockwise (until audible clicking is heard)	Vexc	0.19	0.26
2	Rotate Fully Counter-Clockwise (until audible clicking is heard)	Vexc	3.9	4.1
3	Don't Care	Open	4.9	5.0
4	Replace J4	Vexc	Don't Care	Don't Care

#### Table 4: Hardware Checkout Voltages and Settings



- 8) In the Main Window, under "PGA309 Temp ADC", click on "Convert" (see Figure 16).
- 9) Temperature reading in °C should be the PGA309 ambient +/-2°C. Readout will be in Main Window under "PGA309 Temp ADC" section as shown in Figure 16.

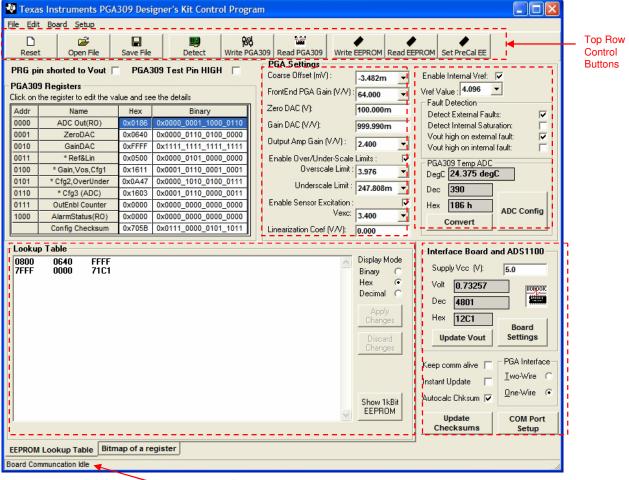


#### Figure 16: Internal Temperature Reading

If all steps above, in Section 6, have been successfully completed then the PGA309 Sensor Interface Board, PGA309 PC Interface Board, PC Cable, PGA309EVM Board Control Software are all operating correctly.

#### 7.0 Board Control Software Overview

Figure 17 depicts the Main Window for the Board Control Software. Subsections of the Main Window (outlined by dashed lines) as well as the "Top Row Control Buttons" and "Board Communication Status" will be described in detail in sections 7.1-7.10.



Communication Status

Figure 17: Main Window



#### 7.1 Top Row Control Buttons

The "Top Row Control Buttons" are described in Table 5.

Button Name	Description	Comments	See Related Figure ?
Reset	Resets all register bit values to zero	Resets values in PC memory only. Requires a "Write to PGA" or "Write to EEPROM" to effect	
Open File	Selects File to open which contains saved EEPROM Configuration Register and Lookup Table values.		Figure 18
Save File	Selects File to save current EEPROM Configuration Register and Lookup Table values.		Figure 18
Detect	Looks for PGA309EVM Boards using current "Port Setup". Configures the board and read the current Register and the Lookup Table values	Both PGA309 Sensor Interface and PGA309 PC Interface must be present and working.	
Write PGA309	Writes all current Main Window values into PGA309 R/W Registers (including setting ZeroDAC and GainDAC).	Unless Test Pin is set high these settings will be overwritten by valid external EEPROM data.	
Read PGA309	Reads all current PGA309 Register values into the Main Window.		
Write EEPROM	Writes current values in the Lookup Table section and PGA309 Register section of the Main Window into external PGA309 EEPROM.		
Read EEPROM	Reads external PGA309 EEPROM values into Main Window.		

#### Table 5: Main Window - Top Row Control Buttons

#### 7.1.1 General Note on Reading & Writing to PGA309 and External EEPROM:

When you do a "Write EEPROM" whatever is in the "Main Window" will be written to the PGA309 external EEPROM *EXCEPT* for the Zero DAC and Gain DAC values in the "PGA Settings" section of the "Main Window". However, in the case of the Zero DAC and the Gain DAC it does not make any sense to write to the EEPROM the settings in the section "PGA Settings" since the Zero DAC and Gain DAC settings can be many values as defined by the Lookup section of the EEPROM. *To write Zero DAC and Gain DAC settings into EEPROM you must update or change the "Lookup Table" section in the "Main Window". Also if you type a number into the Zero DAC or Gain DAC boxes in the "PGA Settings" section of the "Main Window" and then do a "EEPROM Read" the previously typed numbers will remain. To read the current Gain DAC and Zero DAC settings of the PGA309 internal registers and have them updated and displayed in the "PGA Settings" section of the Main Window click on the "Read PGA309" Button.* 

If you want to try different settings on the PGA309 then it is best to check the box "PGA309 Test Pin High" in the upper middle area of the "Main Window" which stops the PGA309 from reading the EEPROM and allows you to "Write PGA309" which will directly change (but *NOT* save to EEPROM) the Zero DAC and Gain DAC settings for trial offset and gain settings, etc.



W	Incert	Format	Tools	Table	Window	Help						
1	Open										? 🗙	
		Look in:	C PG/	4309 De	signer's Kit		•	- ÷	ثم 🖻	•		I
	P	7	🗐 PGA3	309_DK_	Test.txt							Re
	Rec	ent										F
	r.	3										ŀ
	Desl	ktop										P
	~											n-
	My Doc	y uments										L
	-											ŀ
	My Cor	mouter										ľ
		inpator										Г
		2	File name	e:					•	] [	Open	
	My Ne Plac	etwork	Files of ty	ype:	Text (*.t				•	]	Cancel	10
	1 Idi				🗌 Oper	n as read-only	/					
											1107	· ·

#### Figure 18: Typical Write PGA309 or Read PGA309 Pop-up Window

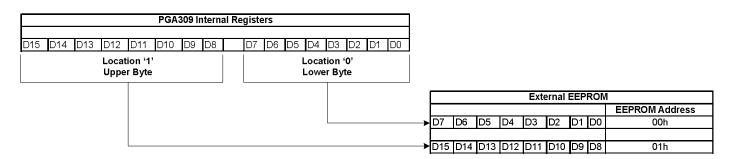
#### 7.2 EEPROM Lookup Table

When the "EEPROM Lookup Table" is selected on the bottom Tab in the Main Window the Temperature Coefficients stored in the PGA309 external EEPROM from the last "Read EEPROM" are displayed in the "Lookup Table" section of the Main Window. These values can be displayed by selecting the desired format as Binary, Hex or Decimal under "Display Mode" in the "Lookup Table" section. See Figure 17. If the entire contents of the EEPROM is to be viewed or edited, in Hex and ASCII only, then click on "Show 1kBit EEPROM" in the "Lookup Table" section of the Main Window. Figure 16 shows the resultant pop-up window which displays the entire external PGA309 EEPROM contents in Hex. Remember the EEPROM contents are mapped **least significant byte first** relative to PGA309 16-Bit registers as shown in Figure 20.

🏁 PG	A309 Board: 1 KBit EE	PROM Content	
Addr	Hex	ASCII	
0 8 16	49 54 00 00 00 00 00 05 11 16 47 0A 03 16 5B 70 00 08 40 06 FF FF FF 7F	IТ G [р @ ····П	Close
24 32 40	00 00 C1 71 FF FF FF FF FF FF FF FF FF FF FF FF	Áq <sup></sup>	Write EEPROM
48 56 64	FF FF FF FF FF FF FF FF FF FF FF FF FF F		
72 80	FF FF FF FF FF FF FF FF FF FF FF FF FF F		
88 96 104	FF FF FF FF FF FF FF FF FF FF FF FF FF F		
112 120	FF FF FF FF FF FF FF FF FF FF FF FF FF F		

Figure 19: PGA309 External EEPROM Pop-up Window





#### Figure 20: PGA309 Internal Registers to PGA309 External EEPROM Mapping

For updating the information in the "EEPROM Lookup Table" section simple click and edit the desired values. Next click on the "Apply Changes" button in the "EEPROM Lookup Table" section. This only updates the information for the Lookup Table information stored on the Test PC. If these new values are desired to be written into the external EEPROM, then after the "Apply Changes" click one must click on the "Write EEPROM" button at the top of the Main Window. If the changes edited in the Lookup Table are desired not to be kept on the Test PC then click on "Discard Changes" and the last values in the Lookup Table stored on the Test PC will be restored.

The other way to directly write to the external EEPROM is through the "PGA309 External EEPROM Pop-up Window" as shown in Figure 19 and discussed above.

#### 7.3 PGA309 Registers

The PGA309 current internal register contents are displayed in the "PGA309 Registers" section of the Main Window. By clicking on the "Bitmap of a register" tab in the bottom left corner of the Main Window the Main Window view will change to that of Figure 21. The lower left quadrant of the Main Window now displays detailed information about the PGA309 register selected by clicking on a specific register listed in the "PGA309 Registers" section of the Main Window. Each bit in the selected register may be toggled by double-clicking on the desired current bit setting. A brief description of each bit also appears. If the "Instant Update" check-box in the lower right of the Main Window is not checked than the "Write PGA309" button will need to be pushed. Remember if you do not want the register settings in the PGA309 to be over-written by valid PGA309 external EEPROM data then ensure the PGA309 Test pin is set high by checking the "PGA309 Test Pin HIGH" box in the upper left area of the Main Window.



0       0       0       0       1       1       1603       <       >         RFB: Reserved Factory Bit: Set to zero for proper operation ADC2X - Temp ADC turbo mode(not for internal Temp Sense Mode): 0=1X speed (6ms typical); 1=2X speed (3ms typical) ADCS - Start (restart) the Temperature ADC (one-shot if CEN=0); 0=No Start/Restart ISEN - 7uA ITEMP Current source on pin TEMPin Enable: 1=Enable: 0=Disable CEN - Continuous convertion mode of Temperature ADC: 1=Continuous; 0=Non-continuous (requires ADCS=1) TEN - Internal Temperature ADC: internal reference: 1=Enable (2.046V typical); 0=Disable (use external ADC reference - see AREN - Temperature ADC internal reference: 1=Enable (2.046V typical); 0=Disable (use external ADC reference - see       Autocalc Chrsum V       One-Wire	Ľ	t Board Setup			<b></b>	669		<b>#</b>		•	
PRG pin shorted to Vout       PGA309 Test Pin HIGH       Coarse Offset (mV):       -3.482m       Enable Internal Viet:       Viet Value       4.096       Viet Value </th <th>Resel</th> <th>t Open Fi</th> <th>ile Sav</th> <th>e File</th> <th>Detect</th> <th>Write PGA</th> <th>309 Read F</th> <th>PGA309 Wri</th> <th>ite EEPROM Read EE</th> <th>PROM</th> <th></th>	Resel	t Open Fi	ile Sav	e File	Detect	Write PGA	309 Read F	PGA309 Wri	ite EEPROM Read EE	PROM	
PCA309 Registers       Coarse Offset (MV):       -3.482m       ✓       Enable internal vert:       ✓         Click on the register to edit the value and see the details       Addr       Name       Hex       Binary       FrontEnd PGA Gain (V/V):       64.000       ✓       Fault Detection         0000       ADC Out(RO)       0x01AZ       0x0000_0110_0100_0000       Gain DAC       0x0FFFF       0x1111_1111_111_111_111_111_111_111_111_	PRG nin	shorted to Vo	ut 🗆 F	GA309 Tes	t Pin HIGH	-		-			
Silick on the register to edit the value and see the details       Addr       Name       Hex       Binary         Addr       Name       Hex       Binary       Gain DAC       Over Value   *Vor			inter 1	0/1000 100	, initiation i	•					
Addr       Name       Hex       Binary         0000       ADC Out(RO)       0x017       0x0000_0001_010_0100_0000         0011       ZeroDAC       0x0640       0x0000_0110_0100_0000         0010       Gain DAC       0x7FFF       0x1111_1111_1111_111         0011       * Ref8Lin       0x0500       0x0000_0101_0000_0000       Output Amp Gain (V/V):       999.990m         0100       * Gain/Xos_Cfg1       0x1611       0x000_0101_0000_0000       Output Amp Gain (V/V):       PGA308 Temp ADC         0100       * Grig A(ADC)       0x1613       0x0000_01010_0010_0011       Overscale Limit :       247.808m       PGA308 Temp ADC         0100       Alernistatus(RO)       0x0000_0000_0000_0000_0000       Overscale Limit :       247.808m       PGA308 Temp ADC         0100       Alernistatus(RO)       0x0000_0000_0000_0000_0000       PGA308 Temp ADC       PGA308 Temp ADC         RFB       RADC_2X       ADCS       ISEN       CEN       TEN       AREN         RFB       RADC_2X       ADCS       ISEN       CEN       TEN       AREN         RFB:       Reserved Factory Bit Set to zero for proper operation       RFB       Reserved Factory Bit Set to zero for proper operation       RFB       Reserved Factory Bit Set to zero for proper operation <td></td> <td>-</td> <td>it the volue o</td> <td>nd one the</td> <td>lotoilo</td> <td></td> <td>FrontEnd</td> <td>PGA Gain (V/</td> <td>V): 64.000 <b>-</b></td> <td>Vref Value 4.096</td> <td></td>		-	it the volue o	nd one the	lotoilo		FrontEnd	PGA Gain (V/	V): 64.000 <b>-</b>	Vref Value 4.096	
Action       Text       Data       Data <thdata< th="">       Data       Data</thdata<>										Fault Detection	
OOI       ZeroDAC       0x0640       0x0000_0110_010_000       0x000_0000       0x000_0000_0000       0x000_0000_0000       0x0000_0111_0000_0000       0x000_0111_0000_0000       0x000_0111_0000_0000       0x000_0111_0000_0000       0x000_0111_0000_0000       0x000_0111_0000_0000       0x000_0111_0000_0000       0x000_0111_0000_0000       0x0000_0111_0000_0000       0x0000_0000_0000_0000       0x0000_0000_0000       0x0000_0000_0000       0x0000_0000_0000_0000       0x0000_0000_0000_0000_0000       0x0000_00000_0000_0000_0000       0x000_0000_0000_0000_						0.0111					
0010       GainDAC       0xFFFF       0x1111_1111_1111_1111       0x1111_0111_1111_1111_1111       0x1 Mign on internal fault:         0010       * Gain/Vos_Cfg1       0x1611       0x0000_0101_0000_0000       vout high on internal fault:         0010       * Gain/Vos_Cfg1       0x1611       0x0001_0110_0001_0001       vout high on internal fault:         0101       * Cfg2_OverUnder       0x0A47       0x0000_01010_0100_0111       Underscale Limit:       3.976       vout high on internal fault:         0110       * Cfg2_OverUnder       0x0A47       0x0000_0000_0000_0000       underscale Limit:       247.808m       vout high on internal fault:         0110       * Cfg3_(ADC)       0x1603       0x0000_0110_000_0101       underscale Limit:       247.808m       veice       deg C       26.4375 degC       deg C       deg C       26.4375 degC       deg C       deg C </td <td></td> <td></td> <td></td> <td></td> <td></td> <td></td> <td>Gain DAC</td> <td>; (VV):</td> <td>999.990m</td> <td></td> <td></td>							Gain DAC	; (VV):	999.990m		
0010       * Callbox       0x111       CN11							Output Ar	np Gain (V/V)	2.400 -	-	
0100       * Gain,Vos,Cfg1       0x1611       0x0001_0110_0001_0001         0101       * Cfg2,OverUnder       0x0A47       0x0000_1010_0100_0111         0101       * Cfg2,OverUnder       0x0A47       0x0000_0000_0000_0000       0underscale Limit:       247.808m       DegC       26.4375 degC         0100       AlarmStatus(RO)       0x0000_0000_0000_0000_0000       0x0000_0000_0000_0000       Vexc:       3.400       Image: Convert       DegC       26.4375 degC         0100       AlarmStatus(RO)       0x0000_00000_0000_0000_0000       0x0000_0000_0000_0000       Image: Convert       Image: Convert       DegC       26.4375 degC       DegC							Enable O	veril Inder.So			an. J
0101       * Cfg2,OverUnder       0x0A47       0x0000_01010_0100_0111         0110       * Cfg3 (ADC)       0x1603       0x0001_0110_0000_0011         0111       OutEnbl Counter       0x0000       0x0000_0000_0000_0000       0underscale Linit:       247.808m       Image: Counce Counce Councer         01000       AlarmStatus(RO)       0x0000_00000_0000_0000       0underscale Linit:       247.808m       Image: Councer       Dec       423         1000       AlarmStatus(RO)       0x0000_00000_0000_0000       0underscale Linit:       247.808m       Image: Councer       Dec       423         1000       AlarmStatus(RO)       0x0000_0000_0000_0000       0underscale Linit:       247.808m       Image: Councer       Dec       423         1000       AlarmStatus(RO)       0x0000_0000_0000_0000       Dec       100       Image: Councer       Dec       423         Register Bitmap       Interface Board and ADS1100       Image: Councer       Dec       100       Out       Dec       100       Out											_
0110       * Crg3 (ADC)       0x1603       0x0001_0110_0000_0011         0110       * Crg3 (ADC)       0x1603       0x0000_0000_0000_0000       0000         0111       Outerbid Counter       0x0000       0x0000_0000_0000_0000       0000         1000       AlarmStatus(RO)       0x0000       0x0000_0000_0000_0000       0000       Vexc:       3.400       Image: Convert         1000       AlarmStatus(RO)       0x0000_0000_0000_0000_0000       0000       0000       Vexc:       3.400       Image: Convert       ADC Config         Register Bitmap       Inearization Coef (V/V):       0.000       0.000       Interface Board and ADS1100         RFB       RFB       ADC_2X       ADCS       ISEN       CEN       TEN       AREN         RFD       RGO       0       0       1       1       1003       <			-								
0111       OutEnbl Counter       0x0000       0x0000_0000_0000_0000_0000_0000_0000_0							U	inderscale Lim	<sup>m</sup> 247.808m ▼	Dec 423	
1000       AlarmStatus(RO)       0x0000       0x0000_0000_0000_0000       0x000       0x0000_0000_0000       0x000       0x0000_0000_0000       0x0000_0000       0x0000_0000_0000       0x0000_0000       0x0000_0000_0000       0x0000_0000       0x0000_0000_0000       0x0000_0000       0x0000_0000_0000       0x0000_0000       0x0000_0000       0x0000_0000_0000       0x0000_0000       0x0000       0x0000_0000       0x0000       0x0000_0000       0x0000       0x0000       0x0000       0x0000       0x0000       0x0000_0000       0x0000       0x00000       0x00000       0x00000       0x00000       0x00000       0x00000       0x00000       0x00000 </td <td>0111</td> <td></td> <td></td> <td></td> <td></td> <td></td> <td>Enable Se</td> <td></td> <td></td> <td>Hex 1A7 h</td> <td></td>	0111						Enable Se			Hex 1A7 h	
Config Checksum       0x705B       0x0111_0000_0101_1011         Register Bitmap         RFB       RFB       ADC_2X       ADCS       ISEN       CEN       TEN       AREN         0       0       0       1       0       Re-read       Supply Vcc (V):       5.0         RV1       RV0       M1       M0       G1       G0       R1       R0       Supply Vcc (V):       5.0         RFB:       Reserved Factory Bit: Set to zero for proper operation       RFB: Reserved Factory Bit: Set to zero for proper operation       ADC2x - Temp ADC turbo mode(not for internal Temp Sense Mode): 0=1X speed (6ms typical); 1=2X speed (3ms typical)       Hex       575       Board         ADC2x - Temp ADC turbo mode(not for internal Temp Sense Mode): 0=1X speed (6ms typical); 1=2X speed (3ms typical)       Hex       575       Board         ADC3 - Start (restart) the Temperature ADC (one-shot if CEN=0); 0=No Start/Restart; 1=Start/Restart       1Start/Restart       Stertings       Board         SEN - 70.4 ITEMP Current source on pin TEMPIn Enable: 1=Enable (0=Disable       Internal mode; 0=Disable       Keep comm alive I two-Wre       PGA Inter         CEN - Continuous convertion mode of Temperature ADC (onde: 1=Enable (0=Disable       Internal mode; 0=Disable (use external ADC reference - see       Autopale Charter I wo-Wre       Internal mode; 0=Disable (use external ADC reference - see       A	1000	AlarmStatus	(RO) 0x0	000 0x00	00_0000_000	0_0000		Ve	×C: 3.400 🔻		DC Config
Register Bitmap         RFB       RFB       ADC_2X       ADCS       ISEN       CEN       TEN       AREN         0       0       0       1       0       Re-read       Supply Voc (V):       5.0         RV1       RV0       M1       M0       G1       G0       0       1       1       1603       < >         RFB:       Reserved Factory Bit: Set to zero for proper operation       RFB: Reserved Factory Bit: Set to zero for proper operation       RFB: Reserved Factory Bit: Set to zero for proper operation       RFB: Reserved Factory Bit: Set to zero for proper operation       Hex       775       Board         ADC2X - Temp ADC turbo mode(not for internal Temp Sense Mode): 0=1X speed (6ims typical); 1=2X speed (3ms       Update Vout       Settings         Vipical)       ADCS - Start (restart) the Temperature ADC (one-shot if CEN=0); 0=No Start/Restart; 1=Start/Restart       ISEN - 7uA ITEMP Current source on pin TEMPin Enable: 1=Enable; 0=Disable       CEN - Continuous convertion mode of Temperature ADC internal mode; 0=Disable internal mode       Keep comm alive Importance       PGA Inter Importance         CEN - Continuous convertion mode of Temperature ADC internal reference: 1=Enable (2.048V typical); 0=Disable (use external ADC reference - see       Autocalc Chissum Importance       One-Wire         AREN - Temperature ADC internal reference: 1=Enable (2.048V typical); 0=Disable (use external ADC reference - see		Config Check	(sum 0x7	05B 0x01	11_0000_010	1_1011	Linearizat	tion Coef (V/V	0.000	Convert	
RFB       RFB       ADC_2X       ADCS       ISEN       CEN       TEN       AREN         0       0       0       1       0       1       1       0       Re-read         RV1       RV0       M1       M0       G1       G0       R1       R0       Re-read       Volt       0.21317       Image: Construct Status         RFB.       Reserved Factory Bit. Set to zero for proper operation       RFE.       Reserved Factory Bit. Set to zero for proper operation       ADC2x - Temp ADC turbo mode(not for internal Temp Sense Mode): 0=1X speed (6ms typical); 1=2X speed (3ms typical)       Hex       575       Board         ADC2x - Temp ADC turbo mode(not for internal Temp Sense Mode): 0=1X speed (6ms typical); 1=2X speed (3ms typical)       Hex       575       Board         ADC2x - Temp ADC turbo mode(not for internal Temp Sense Mode): 0=1X speed (6ms typical); 1=2X speed (3ms typical)       Hex       575       Board         ADC3 - Start (restart) the Temperature ADC (one-shot if CEN=0); 0=No Start/Restart; 1=Start/Restart       SEN - 70.4 ITEMP Current source on pin TEMPin Enable: 1=Enable; 0=Disable       Keep comm alive I       PGA Inter I         CEN - Continuous convertion mode of Temperature ADC internal reference: 1=Enable internal mode; 0=Disable internal adDC reference - see       Instant Update I       Iwo-Wire Qne-Wire Qne-Wire         AREN - Temperature ADC Internal reference: 1=Enable (2.048V ty									, 1		
0       0       0       1       0       1       1       0       Re-read         RV1       RV0       M1       M0       G1       G0       G0       G1       G1 <td< td=""><td>-</td><td>-</td><td>4 D.O. OV</td><td>40.00</td><td>IOCH</td><td>051</td><td>TEN</td><td>4.05N</td><td></td><td>Interface Board and A</td><td>DS1100</td></td<>	-	-	4 D.O. OV	40.00	IOCH	051	TEN	4.05N		Interface Board and A	DS1100
RV1       RV0       M1       M0       G1       G0       R1       R0       R1       R1       R0       R1       <			_					_	Re-read	Supply Vcc (V):	5.0
INV       I									Refeau		7
RFB: Reserved Factory Bit: Set to zero for proper operation         RFB: Reserved Factory Bit: Set to zero for proper operation         ADC2X - Temp ADC turbo mode(not for internal Temp Sense Mode): 0=1X speed (6ms typical); 1=2X speed (3ms ypical)         ADC3 - Start (restart) the Temperature ADC (one-shot if CEN=0); 0=No Start/Restart; 1=Start/Restart         ISEN - 7uA ITEMP Current source on pin TEMPin Enable: 1=Enable; 0=Disable         CEN - Continuous convertion mode of Temperature ADC: 1=Continuous; 0=Non-continuous (requires ADCS=1)         TEN - Internal Temperature ADC internal reference: 1=Enable (2.048V typical); 0)=Disable (use external ADC reference - see	_				_		_			Volt 0.21317	
RFB: Reserved Factory Bit: Set to zero for proper operation       Board         ADC2X - Temp ADC turbo mode(not for internal Temp Sense Mode): 0=1X speed (6ms typical); 1=2X speed (3ms typical)       Update Vout       Board         ADC3 - Start (restart) the Temperature ADC (one-shot if CEN=0); 0=No Start/Restart; 1=Start/Restart       Issue (1 - 2 - 2 - 2 - 2 - 2 - 2 - 2 - 2 - 2 -	0	0	0	0	0	0	1	1	•••• • • • • •	Dec 1397	
RFB: Reserved Factory Bit: Set to zero for proper operation       Board         ADC2X - Temp ADC turbo mode(not for internal Temp Sense Mode): 0=1X speed (6ms typical); 1=2X speed (3ms typical); ADCS - Start (restart) the Temperature ADC (one-shot if CEN=0); 0=No Start/Restart; 1=Start/Restart       Update Vout       Board         ADCS - Start (restart) the Temperature ADC (one-shot if CEN=0); 0=No Start/Restart; 1=Start/Restart       Keep comm alive       PGA Inter         CEN - 7uA ITEMP Current source on pin TEMPin Enable: 1=Enable; 0=Disable       1=Enable; 0=Disable       Image: Non-continuous (requires ADCS=1)       Instart Update       Image: Non-continuous (Reguires ADCS=1)         TEN - Internal Temperature Sensor ADC Mode: 1=Enable (1.048V typical); 0=Disable (use external ADC reference - see       Autocalc Christian Or One-Wree       One-Wree	RFB: Re	eserved Factory	Bit: Set to ze	ro for prope	r operation					Hex 575	-
typical)       ADCS - Start (restart) the Temperature ADC (one-shot if CEN=0); 0=No Start/Restart; 1=Start/Restart       Keep comm alive       PGA Inter         SEN - 7uA ITEMP Current source on pin TEMPin Enable: 1=Enable; 0=Disable       Centinuous; 0=Non-continuous (requires ADCS=1)       Instant Update       Iwo-Wire         TEN - Internal Temperature Sensor ADC Mode: 1=Enable Internal mode; 0=Disable internal mode; 0=Disable (use external ADC reference - see       Instant Update       Iwo-Wire         AREN - Temperature ADC internal reference: 1=Enable (2.048V typical); 0=Disable (use external ADC reference - see       Autocalc Christian Q       One-Wire										010	Board
ADCS - Start (restart) the Temperature ADC (one-shot if CEN=0); 0=No Start/Restart; 1=Start/Restart ISEN - 7UA ITEMP Current source on pin TEMPIn Enable; 1=Enable; 0=Disable CEN - Continuous convertion mode of Temperature ADC: 1=Continuous; 0=Non-continuous (requires ADCS=1) ITEN - Internal Temperature Sensor ADC Mode: 1=Enable Internal mode; 0=Disable Internal mode AREN - Temperature ADC Internal reference: 1=Enable (2.048V typical); 0=Disable (use external ADC reference - see Autocalc Christian Q	IADC2X		o mode(not	for internal 1	femp Sense N	/lode): 0=1X	speed (6ms	typical); 1=2X	speed (3ms	Update Vout	Settings
ISEN - 7uA ITEMP Current source on pin TEMPIn Enable: 1=Enable: 0=Disable CEN - Continuous convertion mode of Temperature ADC: 1=Continuous; 0=Non-continuous (requires ADCS=1) TEN - Internal Temperature Sensor ADC Mode: 1=Enable Internal mode; 0=Disable internal mode AREN - Temperature ADC internal reference: 1=Enable (2.048V typical); 0=Disable (use external ADC reference - see Autocalc Christian Q			e Temperatu	re ADC (on)	e-shot if CEN=	=0): 0=No St	art/Restart: 1	=Start/Restart	t		
TEN - Internal Temperature Sensor ADC Mode: 1=Enable Internal mode; 0=Disable internal mode Instant Update Instant Update One-Wire AREN - Temperature ADC internal reference: 1=Enable (2.048V typical); 0=Disable (use external ADC reference - see Autocalc Chicsum & One-Wire	typical)									Keep comm alive 🔲 🦵	GA Interface
AREN - Temperature ADC Internal reference: 1=Enable (2:048V typical); 0=Disable (use external ADC reference - see Autocale Christian G	typical) ADCS -	UA ITEMP Currer		f Temperatu					ADCS=1)	Instant Lindate	[wo-Wire (
Autocale Chksum	typical) ADCS - ISEN - 7 CEN - C	ontinuous conve			=⊢nable interr	nai mode; 0=			C reference - see		
RV[1:0])	typical) ADCS - ISEN - 7 CEN - C TEN - In	continuous conve iternal Temperatu	ire Sensor A			V typical): 0					
RV[1:0] - Temperature ADC Reference Select (VREF, VEXC, VSA) Update COM PC	typical) ADCS - ISEN - 7 CEN - C TEN - In AREN -	continuous conve iternal Temperatu Temperature AD	ire Sensor A			V typical); 0	-Disable (us	o oxionnan no	010101010100 000	Autocalc Chksum 🔽 📑	<u>J</u> ne-vvire (
M[1:0] - Temperature ADC Input MUX select Select (TEMPin-GNDA, VEXC-TEMPin, VOUT-GNDA, VREF-TEMPin) Opdate Control Checksums Setu Checksums Seture ADC (14) V2 V4 V2 V4 V2 V4 V2 V4 V2 V4 V2 V4	typical) ADCS - ISEN - 7 CEN - C TEN - In AREN - RV[1:0] RV[1:0]	continuous conve iternal Temperatu Temperature AD )  - Temperature A	ure Sensor A C internal re DC Referen	ference: 1= <b>f</b> ce Select (V	Enable (2.048 REF, VEXC, \	/SA)				Autocalc Chksum	COM Port

Figure 21: PGA309 Registers – Main Window

#### 7.4 PGA Settings

Rather than toggling individual bits of the registers described above, the PGA309 can be configured using drop-down menu selections or check-boxes in the "PGA Settings" section of the Main Window contains:

Coarse Offset (mV) FrontEnd PGA Gain (V/V) Zero DAC (V) Gain DAC (V/V) Output Amp Gain (V/V) Enable Over/Under-Scale Limits Overscale Limit Underscale Limit Enable Sensor Excitation Linearization Coef (V/V) Enable Internal Vref Vref Value

Changing these settings will update the corresponding bits of in the register table and vice versa. The current values of these and the PGA309 registers will be automatically updated in the Main Window following a "Read PGA309". The current settings displayed in the Main Window will be written to the PGA309 internal registers following a "Write PGA309" or to the external PGA309 EEPROM following a "Write EEPROM". If the "Instant Update" check-box in the lower right of the Main Window is checked then the PGA309 internal registers will automatically be updated after every change. Remember if you do not want the register settings in the PGA309 to be over-written by valid PGA309 external EEPROM data then ensure the PGA309 Test pin is set high by checking the "PGA309 Test Pin HIGH" box in the upper left area of the Main Window.



#### 7.5 Fault Detection

In the "Fault Detection" section of the Main Window the following check-boxes are provided for fault detection configuration:

Detect External Faults (checked means enable detection of external faults) Detect Internal Faults (checked means enable detection o internal faults) Vout high on external fault (unchecked means Vout low on external fault) Vout high on internal fault (unchecked means Vout low on internal fault)

The current settings of these in the PGA309 registers will be automatically updated in the Main Window following a "Read PGA309". The current settings displayed in the Main Window will be written to the PGA309 internal registers following a "Write PGA309" or to the external PGA309 EEPROM following a "Write EEPROM". If the "Instant Update" check-box in the lower right of the Main Window is checked then the PGA309 internal registers will automatically be updated. Remember if you do not want the register settings in the PGA309 to be over-written by valid PGA309 external EEPROM data then ensure the PGA309 Test pin is set high by checking the "PGA309 Test Pin HIGH" box in the upper left area of the Main Window.

#### 7.6 PGA309 Temp ADC

In the "PGA309 Temp ADC" section of the Main Window the current Temp ADC reading will be displayed if the "Convert" button is pushed. If a continuous update of the Temp ADC contents is desired it can be read and updated about every 0.75 second by checking the box labeled "Keep Comm Alive" in the lower right corner of the Main Window. Please note that this will also prevent the 1s timeout in the PGA309 from expiring thus stopping EEPROM read-back updates even if Test Pin is low.

By clicking on the "ADC Config" button a pop-up window will be displayed as shown in Figure 22. The flexible Temp ADC can be configured as desired for the application. For details of the Temp ADC options and settings see the PGA309 Data Sheet. If the settings are changed and to be applied then click "OK" in the pop-up window. Remember if you do not want the register settings in the PGA309 to be over-written by valid PGA309 external EEPROM data then ensure the PGA309 Test pin is set high by checking the "PGA309 Test Pin HIGH" box in the upper left area of the Main Window. If these changes are to be included in the EEPROM then set the Test pin HIGH while configuring the Temp ADC, then "Write EEPROM" then set Test pin low for continuous EEPROM reads by the PGA309 with the new Temp ADC settings.

		Vref Value Fault Detection Detect External Fault Detect Internal Satura Vout high on externa Vout high on internal PGA309 Temp ADC DegC 29.375 degC Dec 470 Hex 106 h Convert	ADC Config
ADC Configuration with Exter Enable ADC 2x Turbo:	ADC Pre-gain Select 1VV © ADC input 2VV © gain 4VV © 8VV © Diff input TEMPin - GNDa © Vexo - TEMPin © (*) Vout - GNDA © Vref - TEMPin © matible with the stand-	Interface Board an Supply Vcc (V): Vot 4.04083 Dec 26482 Hex 6772 Update Vout Keep comm alive Instant Update Autocale Chksum Update Checksums	6 ADS1100 5.0 Board Settings PGA Interface Iwo-Wire C Qne-Wire C COM Port Setup

Figure 22: PGA309 Temp ADC Configuration & Readback



#### 7.7 Interface Board and ADS1100

In the "Interface Board and ADS1100" section, in the Main Window, click on "Board Settings". A pop-up window will appear as in Figure 23. This pop-up window provides configuration control of the ADS1100 and the Port Expander, PCF8574A.

1-		2 lect
	💐 TI PGA309 Interface Board (ADS1100 and PCF8574A Status)	🗙 it P
	OutputVoltage/Ref Set	tt F 30
	Volt 0.21332 Vs = 5.0 Single Shot Calibrate ADS1100	Ĕ
	Hex 576	
	Decimal 1398 Read ADS1100 Read ADS1100 Gen Call Reset	
ter	CADS Output Register	f
	D15         D14         D13         D12         D11         D10         D9         D8         D7         D6         D5         D4         D3         D2         D1         D0           0         0         0         0         0         1         0         1         0         1         1	an PK
	MSB LSB	c
lese lese	ADS1100 Configuration/Status Register EVM (PCF8574A)	×
( - 1 ) - St	OS         D6         D5         SC         R1         R0         G1         G0         O         I         I         O         O         I         I         O         O         I         I         O         O         I         I         O         O         I         I         O         O         I         I         O         I <thi< th="">         I         I         <thi< <="" th=""><th>Up</th></thi<></thi<>	Up
7u/ Con	MSB LSB MSB LSB	CC
nter Te	mperature ADC internameterence. T=chable (2.0467 typical), 0=Disable (use external ADC reference - see	nt l

Figure 23: "ADS1100 and PCF8574A Status" Window

In the pop-up window the bits under "EVM (PCF8574A)" will toggle when single-clicked. Table 6 describes the use of each of these bits.

If the "Calibrate ADS1100" Button is pushed it will short the two inputs of the ADS1100 together and compute the offset error. All ADS1100 readings which follow will be calibrated to account for this offset error. In addition measure the voltage Vs on the PGA309 PC Interface Board with an accurate meter and enter this voltage in the "Supply Vcc (V)" box in the Main Window or enter this voltage into the "Vs=" box in the pop-up window. After these two ADS1100 calibration steps are complete the ADS1100 is fully calibrated for both gain and offset errors. Each time the "Calibrate ADS1100" Button is pushed a new ADS1100 offset calibration is performed and the subsequent readings will use the latest calibration numbers.

If the "Read ADS1100" button is pushed a single conversion will be performed in the ADS1100. The reading will be updated in both the Main Window and in the pop-up window. If the box labeled "Read ADS1100 Continuously" is checked then both the pop-up window and Main Window ADS1100 readings will be updated about every 2 seconds depending upon the operating system conditions.

The "ADS Output Register" section in the pop-up window is a read-only bit readout of the latest ADS1110 conversion.

The "ADS1100 Configuration Status Register" bits allow for custom configuration of the ADS1100. These bits are toggled by a one-click method in the corresponding box. The default setting is 0x8C. This configures the ADS1100 for Continuous Conversion Mode, Internal PGA=x1, and 8 samples per second data rate. If these settings are changed they can be returned to the initial power-up settings by pushing the "Gen Call Reset" in the pop-up window. If the Vcc voltage on the PGA309 PC Interface Board is changed then the ADS1100 will need to be re-calibrated for gain and offset (this assumes Vcc will become the Vs for the PGA309 Sensor Interface Board). For further ADS1100 details consult the ADS1100 data sheet.



	Logic	Description	Comments
	State		
P7 Test pin	0	PGA309 operates in "Normal / Stand- Alone Mode".	Reads external EEPROM and uses temperature coefficients to update Gain DAC and Zero DAC settings.
	1	PGA309 operates in "Test Mode".	No external EEPROM reads and must be manually written to for changes in DACs or register settings.
P6 nLED2	0	Turns on LED D2 on PGA309 PC Interface Board.	LED D2 is turned on by the Board Control Software if "PGA309 Test Pin HIGH" box in the Main Window is checked.
	1	Turns off LED D2 on PGA309 PC Interface Board.	LED D2 is turned off by the Board Control Software if "PGA309 Test Pin HIGH" box in the Main Window is not checked.
P5 nLED1	0	Turns on LED D1 on PGA309 PC Interface Board.	LED D1 is turned on by the Board Control Software when successful communication has been completed after power-on from zero volts on the PC Interface Board.
	1	Turns off LED D1 on PGA309 PC Interface Board.	
P4	0	Normal ADS1100 input operation.	
ADS1100 Cal	1	Shorts ADS1100 inputs ( $V_{IN+}$ and $V_{IN-}$ ) together for offset calibration.	Used in the ADS1100 calibration sequence by the Board Control Program
P3	<b>0</b> 1	Logic output of port expander port P3, PGA309 PC Interface Board, U5, pin 7.	Spare port expander port available for user application if desired.
P2 2Wen	0	Disables the Two-Wire interface from the PGA309 Sensor Interface Board.	To allow reliable, uninterrupted connection to ADS1100 and PCF8574A when PGA309 is in Stand-Alone Mode set this bit to zero.
	1	Enables the Two-Wire interface from the PGA309 Sensor Interface Board.	To allow for Two-Wire digital communication from PC to PGA309 and external EEPROM.
P1 nVSen	0	Applies Vs to PGA309 Sensor Interface Board.	Important when PRG is connected to Vout on PGA309 to ensure One-Wire communication during power-up.
	1	Removes Vs from PGA309 Sensor Interface Board.	Important when PRG is connected to Vout on PGA309 to ensure One-Wire communication during power-up.
P0 1Wen	0	Disable 4.7kΩ One-Wire pull-up resistor.	Important to disable for unloaded PGA309 Vout accurate reading through ADS1100.
	1	Enable 4.7k $\Omega$ One-Wire pull-up resistor.	

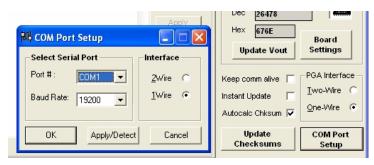
 Table 6: Functionality of Port Expander (PCF8574A) Bits

 (default initial values selected by the Board Control Software are highlighted in bold)



#### 7.8 Interface

The "Interface" section in the Main Window allows for selection of One-Wire or Two-Wire digital communication with the PGA309 Sensor Interface Board. Refer to Figure 24. A single click in the respective circle will select the desired interface. All Board Control Software functionality is supported over either of these interfaces, however the One-Wire interface is the preferred one due to potential conflicts arising from two Two-Wire masters (PC and PGA309) sharing the bus. It is recommended to have PRG wire connected on the PGA309 Sensor Board even when using Two Wire communication. The Board Control Software addresses PGA309 using One-Wire interface prior to closing the switches U10/U11. *This stops any activity by the PGA309 on the Two-Wire interface for 1 second and prevents any bus conflicts.* By pushing the "COM Port Setup" button a pop-up "COM Port Setup" window will appear in the Main Window. In the pop-up window the desired interface may also be selected as well as which PC COM port ("Port #") will be used and the Baud Rate ("Baud Rate") for Communication through the selected COM Port. Drop-down menus are used to select both the desired COM Port and Baud Rate. Once the interface is selected it may be tested by pushing the "Apply/Detect" button or by pushing the "OK" button, in the pop-up window.



#### Figure 24: Interface Section and COM Port Setup Pop-up Window

#### 7.9 Updates

The "Updates" section (see Figure 25) in the Main Window provides options for how certain calculations and readings in the Main Window are updated. If the "Autocalc Chksum" box is checked then both the configuration register part checksum (Checksum1) and the temperature coefficient part checksum (Checksum2) for the external EEPROM are computed automatically after every change. If the box is not checked then the calculations of the checksums may be manually accomplished by pushing the "Update Checksums" button or entering the checksum values directly from hand calculation.

The "Keep comm alive" box, when checked, reads the Temp ADC register and updates the Main Window reading about every 0.75 second, depending upon the operating system used. This will prevent the 1s timeout in the PGA309 from expiring thus stopping EEPROM read-back updates even if Test Pin is set low.

The "Instant Update" box, when checked, updates the PGA309 Registers immediately after every bit change without having to push the "Write PGA309" button. Remember that unless Test pin is set high these settings will be overwritten by valid external EEPROM data.

Keep comm alive 🦵
Instant Update 🛛 🗖
Autocalc Chksum 🔽
Update
Checksums

Figure 25: Updates Section



#### 7.9 Board Communication Status

The "Board Communication Status" section (see Figure 26) is located in the bottom left corner of the Main Window. When reads or write to the PGA309 internal registers or PGA309 external EEPROM are executed messages will appear in this window as confirmation that the communication is taking place successfully.

	1
-	EEPROM Lookup Table Bitmap of a register
ite	Board Communcation Idle

#### Figure 26: "Board Communication Status" Section

#### 7.10 Miscellaneous Main Window Boxes

In the upper left corner of the Main Window, under the "Top Row Control Buttons", there are two check boxes as shown in Figure 27.

"PGA309 Test Pin High" if checked will put a logic high on the Test pin. See Table 6 for the description of the Test pin function. LED D2 on the PGA309 PC Interface Board will be lit whenever this box is checked (Logic High).

If the PGA309 is to be configured with its PRG pin tied to Vout then the box labeled "PRG pin shorted to Vout" (see Figure 27) must be checked for reliable operation. With this box checked the Board Control Software will cycle power on the PGA309 each time it tries to communicate with PGA309 over One Wire interface to ensure that Vout is in high impedance on the PGA309 during the first 25ms after power up.

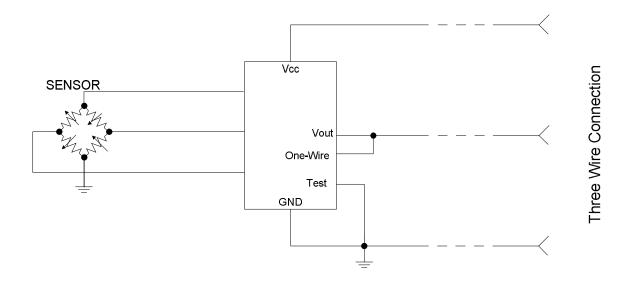


#### Figure 27: Miscellaneous Main Window Boxes

#### 7.11 Calibration Without Using the Test Pin – 3 Wire Modules.

In many cases the PGA309 is connected in a configuration referred to as a three wire configuration. In this configuration the only wires that need to connect to the sensor module are power, ground, and Vout. In this configuration the one-wire digital communication line is connected to the Vout pin. When the PGA309 is initially powered up, the Vout pin is placed in a high impedance mode for 15mS. If communication is established using the one-wire during this time, the PGA309 will keep Vout in high impedance until the communications is complete. After the communication is complete the PGA309 Vout pin will become active and remain active until power is cycled again. While using the EVM to communicate in three wire mode, the EVM will cycle power before each one wire communication. See Figure 28.





#### Figure 28: Three Wire Configuration

One of the key considerations when using connecting a module in a three wire configuration is use of the test pin during calibration. The test pin is typically used during calibration to place the PGA309 into test mode. The main benefit of test mode is that the Gain DAC and Offset DAC are forced to be constant while the device is in test mode.

In the case of three wire mode the test pin is grounded and cannot be used. In this case, an EEPROM table can be built that will force that Gain DAC and Offset DAC to be constant. The PGA309 Designers Kit Control Program "Set Precal EE" feature simplifies the creation of this table. The Operation is as follows:

1) Configure all the registers as is required by your application.

2) Press the Set PreCal EE button. (See Figure 29)

3) The "Pre Cal EEPROM Setup" box will pop up. Press "Generate And Write EEPROM Table".

4) A lookup table will be copied into the EEPROM that will force all of the registers (including Gain DAC and Offset DAC) to your selected values.

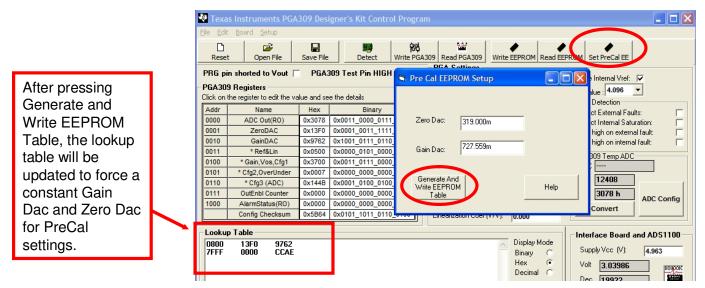
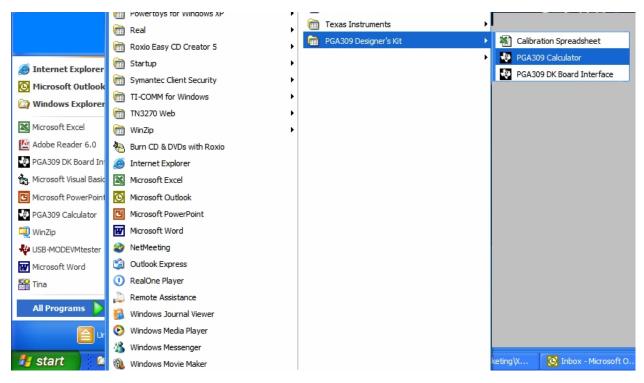


Figure 29: Set PreCal EE Button



# 8.0 PGA309 Calculator (Software for Gain/Offset Calculation and Simulation)

The PGA309 Calculator is a software program that helps to calculate initial gain and offset settings based on your sensor information. The tool also checks to see if the design violates any of the PGA309 specifications. To start the PGA309 Calculator, you select the "PGA309 Calculator" under the "Start" menu, "All Programs", "PGA309 Designer's Kit" as shown in Figure 30.



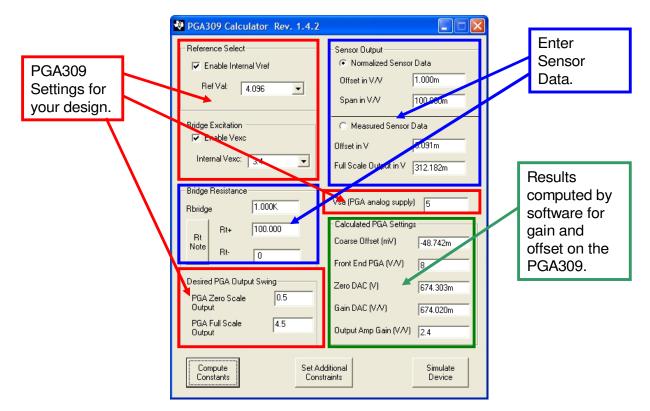
# Figure 30: Starting the PGA309 Calculator

The PGA309 Calculator software will appear as shown in Figure 29. The program requires that you enter the following information about the PGA309: the reference (Vref), the sensor excitation (Vexc), the desired output swing, and the power supply voltage (Vsa). The program also requires that you enter the following information about the sensor: the bridge resistance, the offset, and the span of the sensor. Note that if you plan on using the Rt method for temperature measurement, you should also enter Rt. Also, you can choose to enter the full scale output, and offset of the sensor rather then the span and offset.

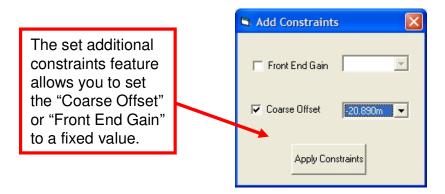
When all the sensor and PGA309 information is entered, press the "Compute Constants" button to calculate the gain, and offset settings for the PGA309. Since there are multiple gain stages in the PGA309, there are many different configurations that can be used to achieve any given gain value. For example, a gain of 500 can be achieved with Front End PGA Gain = 64, Output Amplifier Gain = 2, and Gain DAC = 0.781. A gain of 500 can also be achieved with Front End PGA Gain = 42.67, Output Amplifier Gain = 2.4, and Gain DAC = 0.976. The algorithm that the calculator uses chooses a gain combination that forces the Gain DAC as close to mid scale as possible (Gain DAC=0.667 is ideal). The algorithm also chooses the larges possible Front End PGA Gain to minimize noise. A similar algorithm is used for offset in that the Coarse Offset is selected to set the Offset DAC to mid scale. Setting the Offset and Gain DAC to mid scale allows for the maximum PGA309 adjustment range to compensate for sensor drift.



In cases where you want more control over gain and offset selection, you can force the Front End Gain and / or Coarse Offset to a fixed value using the "Set Additional Constraints". The "Set Additional Constraints" feature can be especially useful if you want to minimize the "Coarse Offset Setting" (See Figure 31). The Coarse Offset feature on the PGA309 uses an auto zero topology. Noise introduced by the auto zero technique can be minimized by using the minimum required coarse offset. Thus, if you don't need the full offset adjustment range, you can use the "Set Additional Constraints" feature to select a minimum value of Coarse Offset.



# Figure 31: PGA309 Calculator



# Figure 32: Set Additional Constraints

Another useful feature of the PGA309 calculator is to simulate the operation of the PGA309. Pressing the "Simulate Device" button on the PGA309 calculator will initiate the simulation. Figure 33 illustrates the Simulate PGA309 form. On this form you can see the state of internal nodes in the PGA309's gain path. Any violation of PGA309 specifications will be identified as an error. Press the "Set Input to Full Scale" and "Set Input to Zero Scale" buttons and verify that your configuration complies with the specifications over your input range. Any register can be modified to see the effect on the design.



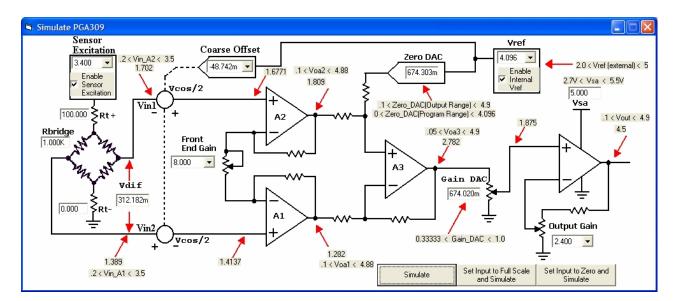


Figure 33: Simulate PGA309

# 9.0 PGA309 + Sensor Calibration Spreadsheet for Microsoft® Excel

**NOTE:** Refer to Section 1.2 to ensure that your version of Excel is properly configured before using the PGA309 Calibration Spreadsheet for Microsoft® Excel.

The PGA309EVM includes a Microsoft® Excel spreadsheet that provides a way to perform a calibration of the sensor module (PGA309 + sensor). The spreadsheet contains two parts:

Sensor Curve-Fitting Equations

Generation of Values for the PGA309 Temperature Lookup Table and Internal Register Settings.

The spreadsheet also contains VBA (Visual Basic for Applications) code that allows its integration with the Board Control Software. These macros allow the user to exchange PGA309 settings between the program and the spreadsheet and save the resulting EEPROM configuration file.

The flexibility and wide availability of Excel determined the platform for this solution. You are free to customize the sensor curve-fit model to fit your sensor better. The only prerequisites are familiarity with Microsoft® Excel capabilities and some limited knowledge of Visual Basic for Applications.

# 9.1 Sensor Curve-Fitting Equations

The built-in equations approximate the sensor with *second order polynomials* for each of the sensor three variables:

- Span vs. temperature;
- Zero offset vs. temperature ;
- Output signal vs. sensor input variable: it will be simply called pressure from now on, but can also be flow or another measured physical parameter.

The sensor curve-fit equation for this case is:

(Equation1) 
$$K_{bridge}(p,T) = k_0 + k_1T + k_2T^2 + (k_3p + k_4p^2) \cdot (1 + k_5T + k_6T^2)$$

where:

 $K_{bridge}$  = bridge output function in V/V of excitation

p = sensor input variable (pressure, etc.)

T = temperature in degrees C

 $k_0, k_1, k_2$  = offset polynomial coefficients (initial, first and second order drift)

 $k_{3},k_{4}$  = input variable sensitivity and non-linearity

 $k_5, k_6$  = span first and second order temperature drift

This is the sensor model used in the PGA309 Calibration Spreadsheet.



There are three degrees of freedom in this equation (offset and span vs. temperature and sensitivity vs. pressure), each of them is described with a quadratic equation. If we don't know much about the sensor (besides that it can be approximated with the Equation1), we need to measure three points on each degree of freedom for curve-fitting, i.e. 9 measurements: zero- and full-scale output at 3 temperatures each for offset and span and output at 3 pressure level for sensitivity. Since the min and max pressure levels for the sensitivity can be combined with zero and span measurements, this reduces the total number to 7 measurements: zero-, half-, full-scale at one of the temperatures; zero- and full-scale at each of two other temperatures. This is called the **3 temperature + 3 pressure calibration**.

Since over-temperature calibration in an oven is often a lengthy and expensive process, it is often preferred to characterize the span and offset drift non-linearities on some number of sensor samples and avoid using the 3<sup>rd</sup> temperature test in production. In this case, if we know that the sensor exhibits, for example 9% span drift non-linearity over the full temperature range and we measure only two points on this curve, we can find the equation coefficients. The same is true for offset drift and pressure non-linearity. By using this pre-characterization method we can reduce the number of required measurements to **2 temperature** points with **2 pressure** levels at each (**2 temperature + 2 pressure calibration**)

In cases when the pressure non-linearity is not known due to bridge resistor value mismatch or other reasons, three pressure levels need to be measured at one of these temperatures (**2 temperature + 3 pressure calibration**).

The PGA309 Calibration Spreadsheet includes templates for each of the three methods described above. The exact equations for curve-fitting the sensor are not included in this document, but can be extracted from the spreadsheet cell formulas.

# 9.2 Calibration of Signal Path Errors

Since we are interested in calibrating the output of a full module, "Sensor+PGA309", we can measure the output of the PGA309. Then we curve-fit the result to the same model. This will take into account all offsets, gain errors and drifts of the amplification signal path.

PGA309 and sensor must be pre-configured with desired settings: reference, excitation level, coarse gain, offset, A/D configuration, etc. The coarse settings should be based on preliminary characterization of the sensor and be such that the PGA309 produces a reasonable valid output signal range (say within 20% of the target) at both zero and full scale pressure level without saturating the internal signal path. Since the circuit offsets can be different at different gains and offset levels, the values of the all coarse settings must remain constant during the calibration processes.

The Lookup Table containing the values of the fine Zero and Gain DACs vs. Temp ADC output is created during the calibration to produce the desired output signal at all temperatures. We recommend to set both Zero and Gain DACs at mid-scale each during calibration as this allows most adjustment range for calibration.

**NOTE:** Set LinDAC=0 (linearization disabled) during calibration or a repeated re-calibration. Its value is also calculated during calibration.



#### 9.3 Spreadsheet Overview

The PGA309EVM Calibration Spreadsheet contains the following parts:

- 1) The "Main" Worksheet is shown in Figure 34. It contains the current values of the PGA309 register table,
  - the lookup table and the control buttons. The buttons have the following functions:
    - A) "Load Registers From File"
      - Read register values from a text file saved by PGA309EVM Board Control Program.
    - B) "Load Registers From PGA309"
      - Read configuration register values directly from the PGA309EVM Board Control Program (must be currently running)
    - Using A) or B) will update the gain, offset and reference values used for calibration.
    - C) "Prepare Calibration Sheet"

Prepare the Worksheet "Sensor Curvefit" for calibration using one of the three templates described in Section 9.1 and start entering calibration measurements;

D) "Save Registers + Lookup Table"

After the calibration has been completed you have to return to this Worksheet and save the resulting configuration register values and the Lookup Table to a text file. The file can be later read by the PGA309 Board Control Program and written into EEPROM on the PGA309 Sensor Interface Board.

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9		* Cfg3 (ADC)		0000_0000		6										
10		OutEnbl Counter		0000_0000		7										
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Figure 34: "Main" Worksheet



2) The "Sensor Curvefit" Worksheet (Figure 35) is the place where all results of the calibration measurements are entered and the sensor compensation coefficients are calculated. The fields colored light blue contain pre-selected values, such as PGA309 Gain and Offset settings, the temperatures where the measurements are made and sensor pre-characterized parameters (such as span drift non-linearity). The dark-blue fields are the ones where the measured values are entered at each stage of the calibration. The framed area is filled out when "Prepare Calibration Sheet" is clicked on the previous page. It contains the cells with calculations specific to the chosen calibration algorithm. The two control buttons paste in the current worksheet cell either the last Vout reading or the last Temp ADC value from the Board Control Program. This saves the manual typing of the numbers. However, all the data can be also entered manually if the measurements are made with other equipment than the PGA309EVM PC Interface Board.

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	Troom= Insert TempADC rea Measurement Tempe Tmeas1 (room)= Tmeas2 (hot)= Tmeas3 (cold)= Measured Data (assu Measurement Temp 20 20 20 20	ding in active cell ratures: 22 88 -40 ming the sensor d Conditions Pressure 0 50 100	TempADC Rea 24744 20498 28668 rectly): Measured Data VoutMeas 5.00E-01 2.50E+00 4.50E+00	Insert Vout decimal decimal RTISpan, V/V RTI Kbrg,v/v -1.06E-01 -3.13E-02 4.38E-02	reading in act : @ this Tem Post First Ca Pressure 0	p 3 pressure al Correction Meas Data VoutMeas		AdcVref=			1.5E-01 1.0E-01 5.0E-02 0.0E+00		B:	ridge se	
	Troom= Insert TempADC rea Measurement Tempe Tmeas1 (room)= Tmeas2 (hot)= Tmeas3 (cold)= Measured Data (asso Measurement Temp 20 20 20 20 85	21 ding in active cell ratures: 21 88 -40 ming the sensor 0 Conditions Pressure 0 50 100 100	TempADC Reat 24744 20498 28668 rectly): Measured Data VoutMeas 5.00E-01 4.50E+00 5.00E-01	Insert Vout decimal decimal decimal RTISpan, V/V RTI Kbrg,v/v -1.06E-01 -3.13E-02 -3.38E-02 -1.06E-01	reading in act : @ this Tem Post First Ca Pressure 0	p 3 pressure al Correction Meas Data VoutMeas		AdcVref=			1.5E-01 1.0E-01 5.0E-02 0.0E+00		B:	ridge se	
	Troom= Insert TempADC rea Measurement Tempe Tmeas1 (room)= Tmeas2 (hot)= Tmeas3 (cold)= Measured Data (asso Measurement Temp 20 20 20 20 85	21 ding in active cell ratures: 21 88 -40 ming the sensor 0 Conditions Pressure 0 50 100 100	TempADC Reat 24744 20498 28668 rectly): Measured Data VoutMeas 5.00E-01 4.50E+00 5.00E-01	Insert Vout decimal decimal decimal RTISpan, V/V RTI Kbrg,v/v -1.06E-01 -3.13E-02 -3.38E-02 -1.06E-01	reading in act : @ this Tem Post First Ca Pressure 0	p 3 pressure al Correction Meas Data VoutMeas		AdcVref=			1.5E-01 1.0E-01 5.0E-02 0.0E+00		B	ridge se	
	Troom= Insert TempADC rea Measurement Tempe Tmeas1 (room)= Tmeas2 (hot)= Tmeas3 (cold)= Measurement Temp 20 20 20 20 85 85 85	ding in active cell ratures: 22 88 -40 ming the sensor d Conditions Pressure 0 50 100 0 100	TempADC Rea 24744 20498 28668 rectly): Measured Data VoutMeas 5.00E-01 2.50E+00 4.50E+00 5.00E-01 4.50E+00	Insert Vout ding@Tmeas decimal decimal RTISpan, V/V RTI Kbrg.v/v -1.06E-01 -3.13E-02 -4.38E-02 -1.06E-01 4.38E-02	reading in act @ this Tem Post First Ca Pressure 0 100	p 3 pressure	e levels are	applied		Khidao VV or Vhidao VV	1.5E-01 1.0E-01 5.0E-02 0.0E+00	-50	B	ridge se	
	Troom= Insert TempADC rea Measurement Tempe Tmeas1 (room)= Tmeas2 (hot)= Tmeas3 (cold)= Measured Data (assu- Measurement Temp 20 20 20 20 20 85 85 -40	21 ding in active cell ratures: 21 88 -40 0 50 100 0 100 0 0 0 0 100 0 0 0 0 0 0 0 0 0 0 0 0	TempADC Reat 24744 20498 28668 rectly): Measured Data VoutMeas 5.00E-01 4.50E+00 5.00E-01 4.50E+00 5.00E-01	Insert Vout decimal decimal RTISpan, V/V RTI Kbrg,v/v -1.06E-01 -3.13E-02 4.38E-02 -1.06E-01 4.38E-02 -1.06E-01 4.38E-02 Room Temp Gai	reading in act : @ this Tem Post First Ca Pressure 0 100	ive cell p 3 pressure al Correction Meas Data VoutMeas	PGA_Min	AdcVref=			1.5E-01 1.0E-01 5.0E-02 0.0E+00	50	B:	ridge se	
	Troom= Insert TempADC rea Measurement Tempe Tmeas1 (room)= Tmeas2 (hot)= Tmeas3 (cold)= Measured Data (assu- Measurement Temp 20 20 20 20 20 85 85 -40	21 ding in active cell ratures: 21 8 -40 conditions Pressure 0 50 100 0 100 0 0 0 0 0 0 0 0 0 0 0 0	TempADC Reat 24744 20498 28668 rectly): Measured Data VoutMeas 5.00E-01 4.50E+00 5.00E-01 4.50E+00 5.00E-01	Insert Vout decimal decimal RTISpan, V/V RTI Kbrg.v/v 1.06E-01 4.38E-02 -1.06E-01 4.38E-02 -1.06E-01 4.38E-02 Room Temp Gaii Room Temp Car	reading in act : @ this Tem Post First Ca Pressure 0 100 100 n Error: Gain Dac:	ve cell p 3 pressure al Correction Meas Data VoutMeas 1 1 1	PGA_Min PGA_Max	AdcVref=			1.5E-01 1.0E-01 5.0E-02 0.0E+00 -5.0E-02 -1.0E-01	50	B	ridge se	
	Troom= Insert TempADC rea Measurement Tempe Tmeas1 (room)= Tmeas2 (hot)= Tmeas3 (cold)= Measured Data (assu- Measurement Temp 20 20 20 20 20 85 85 -40	21 ding in active cell ratures: 21 8 -40 conditions Pressure 0 50 100 0 100 0 0 0 0 0 0 0 0 0 0 0 0	TempADC Reat 24744 20498 28668 rectly): Measured Data VoutMeas 5.00E-01 4.50E+00 5.00E-01 4.50E+00 5.00E-01	Insert Vout ding@Tmeas decimal decimal decimal RTISpan, V/V -1.06E-01 -3.13E-02 4.38E-02 -1.06E-01 4.38E-02 Room Temp Gai Room Temp Gai Room Temp Gai Room Temp Gai RTI Kbr	reading in act @ this Tem Post First Ca Pressure 0 100 100 n Error: Gain Dac: g(Pin_min):	ve cell p 3 pressure l Correction Meas Data VoutMeas 1 1 1 1 1 0.53125	PGA Min PGA Ma GainDAC	AdcVref=			1.5E-01 1.0E-01 5.0E-02 0.0E+00		B	ridge se	
	Troom= Insert TempADC rea Measurement Tempe Tmeas1 (room)= Tmeas2 (hot)= Tmeas3 (cold)= Measured Data (assu Measurement Temp 20 20 20 20 20 20 85 85 -40 -40	21 ding in active cell ratures: 22 88 -44 ming the sensor d Conditions Pressure 0 50 100 0 100 100 100	TempADC Reat 24744 20498 28668 rectly): Measured Data VoutMeas 5.00E-01 2.50E+00 4.50E+00 5.00E-01 4.50E+00 5.00E-01 4.50E+00	Insert Vout decimal decimal RTISpan, V/V RTI Kbrg.v/v 1.06E-01 4.38E-02 -1.06E-01 4.38E-02 -1.06E-01 4.38E-02 Room Temp Gaii Room Temp Car	reading in act @ this Tem Post First Ca Pressure 0 100 100 n Error: Gain Dac: g(Pin_min):	ve cell p 3 pressure l Correction Meas Data VoutMeas 1 1 1 1 1 0.53125	PGA Min PGA Ma GainDAC	AdcVref=			1.5E-01 1.0E-01 5.0E-02 0.0E+00 -5.0E-02 -1.0E-01	50	B		50
	Troom=           Insert TempADC read           Measurement Tempe           Tmeas2 (hot)=           Tmeas3 (cold)=           Measured Data (ass:           Measurement           Temp           20           20           20           20           40           -40           Set Pressure = 0 and	21 ding in active cell ratures: 22 88 -44 ming the sensor d Conditions Pressure 0 50 100 0 100 100 100	TempADC Reat 24744 20498 28668 rectly): Measured Data VoutMeas 5.00E-01 2.50E+00 4.50E+00 5.00E-01 4.50E+00 5.00E-01 4.50E+00	Insert Vout ding@Tmeas decimal decimal decimal RTISpan, V/V -1.06E-01 -3.13E-02 4.38E-02 -1.06E-01 4.38E-02 Room Temp Gai Room Temp Gai Room Temp Gai Room Temp Gai RTI Kbr	reading in act @ this Tem Post First Ca Pressure 0 100 100 contemport Gain Dac: g(Pin_min): g(Pin_max):	ve cell p 3 pressure contraction Meas Data VoutMeas 1 1 1 0.5312E 0.21875	PGA Min PGA Ma GainDAC	AdcVref=	1 0		1.5E-01 1.0E-01 5.0E-02 0.0E+00 -5.0E-02 -1.0E-01	50	B		
	Troom= Insert TempADC rea Insert TempADC rea Insert Tempe Tmeas2 (hot)= Tmeas2 (cold)= Measured Data (assu Measured Data (assu Temp 20 20 20 20 20 85 85 -40 -40 Set Pressure = 0 and Matrix1:	ding in active cell ratures: 22 88 -40 ming the sensor of Conditions Pressure 0 50 100 100 100 100 100	TempADC Reat 24744 20498 28668 rectly): Measured Data VoutMeas 5.00E-01 4.50E+00 5.00E-01 4.50E+00 5.00E-01 4.50E+00 3 temperatures:	Insert Vout ding@Tmeas decimal decimal decimal RTISpan, V/V -1.06E-01 -3.13E-02 4.38E-02 -1.06E-01 4.38E-02 Room Temp Gai Room Temp Gai Room Temp Gai Room Temp Gai RTI Kbr	reading in act @ this Tem Post First Ca Pressure 0 100 100 n Error: Gain Dac: g(Pin_min): g(Pin_max): ResultVector	ve cell p 3 pressure contraction Meas Data VoutMeas 1 1 1 0.5312E 0.21875	PGA Min PGA Ma GainDAC	AdcVref= applied applied Output Room Correction: Solution (coe	1 0 fs vals):		1.5E-01 1.0E-01 5.0E-02 0.0E+00 -5.0E-02 -1.0E-01	50	B		50
	Troom=           Insert TempADC read           Measurement Tempe           Tmeas2 (hot)=           Tmeas3 (cold)=           Measurement           Temp           20           20           20           20           20           85           85           -40           -40           Set Pressure = 0 and Matrix1:	ding in active cell ratures: 22 88 -40 ming the sensor of Conditions Pressure 0 50 100 100 100 100 100	TempADC Reat 24744 20498 28668 rectly): Measured Data VoutMeas 5.00E-01 4.50E+00 5.00E-01 4.50E+00 5.00E-01 4.50E+00 3 temperatures: 7225	Insert Vout decimal decimal decimal RTISpan, V/V RTI Kbrg,v/v -1.06E-01 -3.13E-02 4.38E-02 -1.06E-01 4.38E-02 -1.06E-01 4.38E-02 Room Temp Gai Room Temp Gai	reading in act @ this Tem Post First Ca Pressure 0 100 100 contemport Gain Dac: g(Pin_min): g(Pin_max):	ve cell p 3 pressure contraction Meas Data VoutMeas 1 1 1 0.5312E 0.21875	PGA Min PGA Ma GainDAC	AdcVref=	1 0		1.5E-01 1.0E-01 5.0E-02 0.0E+00 -5.0E-02 -1.0E-01	50	• • • • • • • • • • • • • • • • • • •		50

Figure 35: Sensor Curvefit Worksheet



Upon completion of the measurements the fitted sensor function is displayed on two plots located on this worksheet (see Figure 36).

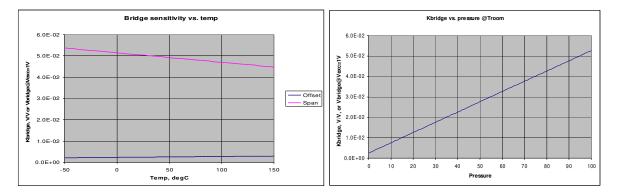


Figure 36: Approximated Sensor Curves

3) The third worksheet is called "Calibration Results" (see Figure 37). It contains the calculated lookup table based on the curve-fitting coefficients from the calibration measurements. The blue fields are for the user data with the desired output voltage scale, compensation temperature range and the number of the lookup table points needed. The framed cells contain the messages about the validity of the calculated values: whether the DAC and Temp ADC values are in linear range achievable by PGA309 at all temperatures and the Table is arranged properly. The plot on the bottom shows the expected PGA309 output vs. temperature at zero and full-scale output signal.

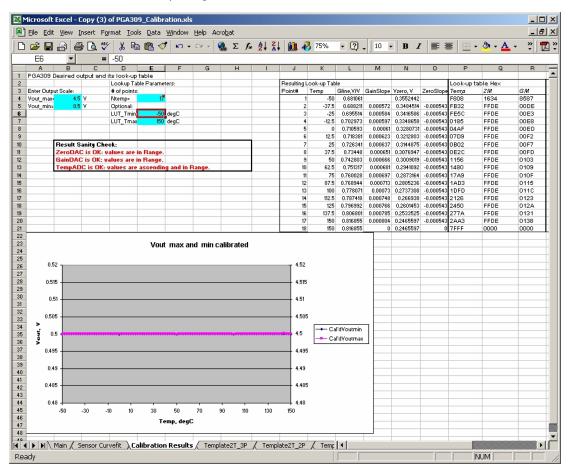


Figure 37: Calibration Results



4) The remainder of the worksheets contain the templates of the curve-fitting algorithms and back-ground calculation data

# 9.4 Step-by-Step Calibration Using PGA309 Designer's Kit.

- 1) The PGA309EVM Sensor Interface Board with a sensor or a custom module are initially configured as described in Section 8.2. It is measured at the first (usually the room) temperature, *Tmeas1*, and at either 2 or 3 pressure levels (see Section 8.1). The output should be within the adjustment ranges of the Zero and Gain DACs. It is important to enable the EXTEN and INTEN bits and/or read back the Alarm Status (Register 8) to see if any of the external or internal comparators raised a flag indicating either sensor fault or an internal signal path saturation. In case of a fault or an unsatisfactory output signal range the coarse settings must be adjusted and the measurement repeated. After a valid output range has been achieved, the following settings must remain fixed:
  - § Reference and Excitation Level
  - § Coarse RTI Offset,
  - § Coarse Front-End and Output Amplifier Gains,
  - § Temp ADC Configuration, etc.
- 2) The current configuration must be entered into the PGA309 Calibration spreadsheet. To do this, perform the following actions:
- A) Open the PGA309 Calibration Spreadsheet (click "Enable Macros" if asked). Upon opening you will be asked if you would like to open the "PGA309EVM Board Control Program". Answer "Yes". If you already have the software running, a new window will not be open, but a data link will be established.
  - B) Make sure the current PGA309 register values are displayed in the Board Control Program (click "Read PGA309" button – see Figure 38).



# Figure 38: Board Control Software Main Window "Read PGA" Button

- C) Return to the "Main" Worksheet and click "Load Registers from Bench". The register values in the cells B3:B12 will be updated. The values of the gain, offset and other parameters are set on the next worksheet accordingly to the PGA309 register configuration.
- D) Click "Prepare Calibration Sheet". The dialog box in Figure 39 will appear. Select the appropriate algorithm. The script will copy the right template to the "Sensor Curvefit" Worksheet and open the next page.
- E) Select the appropriate Temperature Calibration Method (see Figure 40).



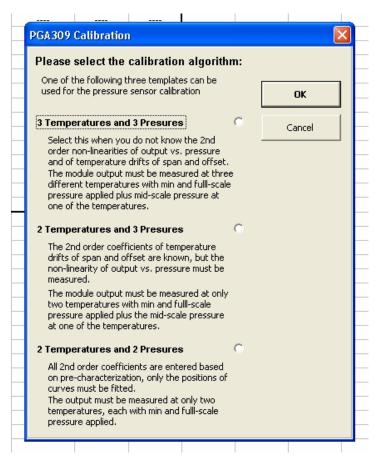


Figure 39: Select Calibration Algorithm Dialog

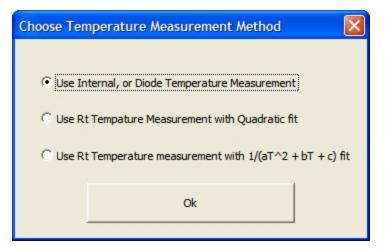


Figure 40: Choose Temperature Calibration Method

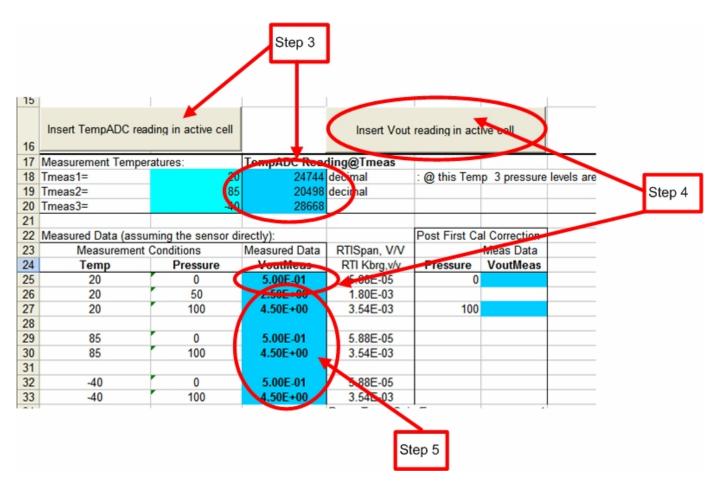


F) Verify and correct the parameter values in the light-blue cells on the "Sensor Curvefit" Worksheet. (Figure 41). Note that the "ExtraGain" and "ExtraOffset" fields are used if an external amplifier is used to scale the output of the PGA309. If an external scaling amplifier is not used, ExtraGain should be set to 1 and ExtraOffset should be set to zero. This is the default settings.

Fill out the highlighted	d cells	PGA309 non-vai	riable (durin	g calibratio	n) settings:								
Pressure values:					· · ·	Initial setting	s of the Fine	Adjust D	ACs:		Used For Ad	ditional G	ain Sca
Pmin=	0	Vref=	5.000	V		GainDAC1=	8000	hex, ==>	> 0.6667	V/V	ExtraGain	1.00	
Pmax=	100	Kexc=	1.000	V/V		ZeroDAC1=	<b>6</b> 008	hex, ==>	> 2.5000	V	ExtraOffset	0.00	
		FrontEnd PGA=	4	V/V									
Temp range:		Output Amp=	2	V/V		Temperature	ADC Setting	js Used	For Rt Calc	Only			
Tmin=	-45	Coarse Offset=	0.00E+00	V		Rt=	Leave this	cell blank	- Rt is not u	sed in this	configuration		
Tmax=	90					No. of Bits=	11						
Troom=	20	Vexc=	5.000	V, with LinD	AC=0	AdcGain=	1						
						AdcVref=					_		
											в	ridge se	nsitivi
Incort TompADC rop	ding in active cell	Incost Vout	roading in ad	tive cell									

Figure 41: Top Part of the "Curvefit" Worksheet

3) On the "Sensor Curvefit" Worksheet, highlight the cell C18 (ADC read @ Tmeas1) and click the button "Insert Temp ADC Reading" (Figure 42).



# Figure 42: Entering the Values for Tmeas1 and Vout @ Tmeas1

4) For the example shown, highlight the cell C25 (VoutMeas @ Pmin, Tmeas1) and click the button Insert "Vout Reading" or enter the measured voltage by hand (Figure 40). The example shown is for three pressures three temperature calibration. Other calibrations are done in a similar manner, but the number of readings required and the cells used will differ.

5) Repeat Step 4 for measuring the max-scale (C27) and (if needed) mid-scale (C26) Vout values.



- 6) Place the Sensor + PGA309 at the temperature Tmeas2 and repeat the Steps 3, 4, 5 entering the values to the corresponding cells below the ones shown in Figure 40. At each stage make sure the signal path of the PGA309 is not overloaded by reading the state of the Alarm Register.
- 7) If using the "2 Temperature + 3 Pressures" or "2 Temperature + 2 Pressures" algorithms, enter the second order parameter non-linearities of the sensor in the highlighted cells B33:B36.
- 8) Verify that the resulting fitted sensor approximation (Figure 36) are in agreement with the characterization data.
- 9) Go to the next Worksheet, "Calibration Results", and enter the desired output voltage scale in the cells B4, B5, the number of the Lookup Table points in the cell E4 and the temperature range where the calibrated output signal is expected in cells E6, E7 (see Figure 43). Note that this can be a narrower range than the Tmin-Tmax range used for the sensor curve-fitting. Using a smaller temp range will reduce the spacing between the points on the piece-wise linear (PWL) gain and offset curves generated by PGA309. This in turn, will reduce the residual 3<sup>rd</sup> order errors of the output. The resulting lookup table and the simulated plot at the bottom of the page get instantly updated. The plot axes might have to be adjusted to display the curves properly. Pay attention to the "Result Sanity Check" messages in the cells B11:B13. If the required DAC or ADC values are outside of the linear ranges of the PGA309 the message will inform you about it. This means that the coarse parameters of the PGA309 must be adjusted and the calibration has to be repeated.

PGA309 Desired output and									
	Lookup Table Parameters:	Resulting	Look-up Ta	ole				Look-up t	table Hex
Enter Output Scale:	# of points:	Point#	Temp	Gfine,V/V	GainSlope	Vzero, V	ZeroSlope	Temp	ZM
Vout_max= 4.5 V	Ntemp= 17	1	-50	0.703735		0.286542		F808	11E9
Vout_min= 0.5 V	Optional:	2	-37.5	0.706215	0.000198	0.29596	0.000753	FB32	002F
	LUT_Tmin= -50 degC	3	-25	0.709357	0.000251	0.303348	0.000591	FE5C	0026
	LUT_Tmax 150 degC	4	-12.5	0.713177	0.000306	0.308706	0.000429	0185	001B
		5	; c	0.717697	0.000362	0.312034	0.000266	04AF	0011
		e	12.5	0.722944	0.00042	0.313332	0.000104	07D9	0006
Result Sanity Che	ck:	7	25	0.728947	0.00048	0.3126	-5.85E-05	0B02	FFFD
ZeroDAC is OK: v	alues are in Range.	8	37.5	0.735743	0.000544	0.309839	-0.000221	0E2C	FFF2
GainDAC is OK: v	alues are in Range.	9	50	0.743374	0.00061	0.305048	-0.000383	1156	FFE8
TempADC is OK:	values are ascending and in Range.	10	62.5	0.751888	0.000681	0.298227	-0.000546	1480	FFDE
		11	75	0.76134	0.000756	0.289376	-0.000708	17A9	FFD3
		12	87.5	0.771795	0.000836	0.278495	-0.00087	1AD3	FFC9
		13	100	0.783326	0.000922	0.265584	-0.001033	1DFD	FFBF
		14	112.5	0.796016	0.001015	0.250644	-0.001195	2126	FFB4
		15	125	0.809964	0.001116	0.233674	-0.001358	2450	FFAA
		16	137.5	0.82528	0.001225	0.214673	-0.00152	277A	FFA0
		17	150	0.842093	0.001345	0.193643	-0.001682	2AA3	FF95
		18	150	0.842093	0	0.193643	0	7FFF	0000
	Vout max and min calibrated								

#### Figure 43: Calibration Results Worksheet

- 10) Return to the "Main" Worksheet and click on the "Save Register+Lookup Table" button to save the calibration results in a file. Now load this file to the PGA309 EEPROM using Board Control Program by using the "Open File" button, and then the "Write EEPROM" button.
- 11) Verify that the output of the PGA309 is satisfactory.
- 12) Optional: To account for the Lin DAC, offset, and gain errors of the PGA309 ZeroDAC and GainDAC, two additional measurements might need to be performed after Step 11. This should improve the calibrated output precision. For example, a sensor with span and offset drift errors on the order of 15% of span will have a post calibration error of less then 0.3%. After the secondary calibration, the error is typically less then 0.1%. See Figure 44.



13	zero This	r the first calibra and full scale secondary cal rall accuracy.	data at room t	emperature.	secon GainD		ation are s tion shou	shown here Id be abou	e. The	;
16	Insert TempADC read	ding in active cell		Insert Vout	reading in act	ive cell				
	Measurement Temper	aturaa:	TempADC Rea	ding@Tmoos						_
	Tmeas1=	20 atures.		decimal	this Tom	p 3 pressure	lovele are a	pplied		_
	Tmeas2=	85		decimal	. y uns rem	p 5 pressure	ieveis ale a	ipplied		
	Tmeas3=	-40		decimal						_
21	meass	40	20000							_
_	Measured Data (assu	ming the sensor di	rectly):		Post First Ca	Correction				_
23	Measurement		Measured Data	RTISpan, V/V		Mez Data				_
24	Temp	Pressure	VoutMeas	RTI Kbrg.v/v	Pressure	VoutMeas				
25	20	0	4.00E-01	-2.83E-05	0	5.00E-01				
26	20	50	2.55E+00	1.84E-03						
27	20	100	4.50E+00	3.54E-03	100	4.50E+00				
28										
29	85	0	5.00E-01	5.88E-05			ľ			
30	85	100	4.51E+00	3.55E-03						
31										
32	-40	0	5.10E-01	6.75E-05						
33	-40	100	4.50E+00	3.54E-03						
34				Room Temp Gai		1.00036				
35				Room Temp Cor		0.64081088				_
36				Post Cal RTI Kb			GainDAC C		0.9996401	_
37				Post Cal RTI Kb	g(Pin_max):	0.01344402	ZeroDAC C	orrection.	0.0001907	1
	Set Pressure = 0 and	measurements at	3 temperatures:							_
39	Matrix1:				ResultVector	1		Solution (co	ef's vals):	_

# Figure 44: Second Calibration for Improved Accuracy.

# 9.5 Customization of the PGA309EVM Calibration Spreadsheet

All of the cells as well as the VBA code in the spreadsheet are open and can be modified and adjusted for individual design and sensor properties. The name of the custom sensor curve-fitting function is *sensbridge()*. This function can be modified to fit sensors modeled by more complex equations than shown in Equation1. In this case the following parts of the spreadsheet must also be updated:

- curve-fitting coefficient equations in the framed area A17:I52, worksheet Sensor Curvefit;
- references to the *sensbridge()* in the cell equations in the worksheet Sensor Data vs. Temp, columns D, F, K, L;
- references to the *sensbridge()* in the cell equations in the worksheet Sensor Data vs. Pressure, column B

*Note:* The equations generating the Lookup Table in the worksheet Calibration Results can stay.



# **10.0 General Operating Tips**

- During initial evaluation of the PGA309 + Sensor it is recommended to leave the PRG pin separate from the Vout pin of the PGA309. Disable the Two-Wire interface on the PGA309 PC Interface Board and use the One-Wire Interface. Disabling the Two-Wire interface keeps communications to the PGA309 PC Interface port expander, PCF8574A, and A/D Converter, ADS1100, from being delayed by the PGA309 talking to its external EEPROM, if PGA309 is in Stand-Alone Mode. Communication on the One-Wire interface will always be recognized and will stop PGA309 to external EEPROM communication.
- 2) For final production testing on 3 terminal sensor modules (Vcc, GND, Vout), where PRG is tied to Vout, use the One-Wire hardware pull-up on the PGA309 PC Interface Board for reliable logic level transitions.
- 3) Upon initial receipt of the PGA309EVM, first perform the Initial Setup and Checkout as described in Section 6.0. If there is ever a doubt as to proper functioning of the PGA309EVM return to this configuration and use Section 6.0 to verify proper operation. Next configure the PGA309 Sensor Interface Board with your Sensor for evaluation. Connect the PGA309 Sensor Interface Board to the PGA309 PC Interface Board using wire to connect the required signals together. If all tests pass then move the PGA309 Sensor Interface Board into the temperature chamber for PGA309 + Sensor calibration.
- 4) When Reading and Writing to the PGA309 through the Board Interface Software push the desired button in the Main Window ONE TIME and wait until the "Board Communication Status" returns to "Board Communication Idle" before pushing any button. Repeated pushing of buttons when the Board Software is in the middle of communication with the PGA309 will cause unreliable data transfer and nuisance errors.
- 5) The "most quiet" analog readings, with a voltmeter or oscilloscope, on Vout of the PGA309 are accomplished when there is no digital activity from the test PC to the PGA309 PC Interface Board and the PGA309 Two-Wire Bus is isolated from the PGA309 PC Interface Board. The RS-232 interface chip, U9 (MAX3238), on the PGA309 PC Interface Board has a shutdown feature which disables the on-board positive and negative charge pumps. These capacitive charge pumps are noisy and every attempt has been made on the PC Interface board to filter them away from the Vs for the PGA309. However, some amount of noise does still exist and as such does not give a true indication of the PGA309 noise performance on its output (Vout). After 30 seconds of inactivity on U9 the internal charge pumps are shutdown. Easiest check that U9 is in shutdown is to probe TP:V- for a voltage reading of <0.1Vdc. To ensure U9 goes into shutdown cease all communications to the PC Interface Board through the RS-232 Interface (Ppc) and ensure that the Two-Wire interface is disabled form the Sensor Interface Board through either software or hardware program selection of disable on U10 and U11. Once U9 is shutdown a "quiet" reading on Vout of the PGA309 can be taken.</p>
- 6) The on-board ADC, ADS1100, on the PGA309 PC Interface Board requires two calibration steps for optimal accuracy. The "gain" of the ADS1100 is set by its reference voltage which is the supply, Vs. Measure Vs on the PGA309 PC Interface Board test point TP:Vs. Ensure that the nVsens bit in the PCF8574A port expander is set to '0' (See Figure 19: ADS1100 and PCF8574A Status and Control Pop-up Window) to turn Vs on. Enter the measured value of Vs into the "Supply Vcc (V)" box under the "Interface board and ADS1100" in the Main Window. After this is complete go to the "ADS1100 and PCF8574A Status" pop-up window (See Figure 19). Click on "Calibrate the ADS1100". This will measure the offset on the ADS1100 and the Board Control Software will adjust all future readings to account for the offset.



# 10.1 PGA309DK Two-Wire Interface and Long Leads

# Effect:

When using the PGA309DK, with long leads between the "PGA309 PC Interface Board" and the "PGA309 Sensor Interface Board" for the Two-Wire Interface (SDA, SCL), while the PGA309 is operating in "Stand Alone Mode" and the "Read ADS1100 Continuously" function is enabled, an error can occur as shown in Figure 45.



# Figure 45: "Read ADS1100 Continuously" Error Message

# Cause & Solution:

Long leads add capacitance and inductance to the SDA and SCL lines going into the "PGA309 PC Interface Board". Even though U10 and U11, on the "PGA309 PC Interface Board", were intended to isolate the "PGA309 PC Interface Board" Two-Wire Interface from the PGA309-to-EEPROM Two-Wire Interface there is capacitive feed-through on falling edges of the PGA309-to-EEPROM Two-Wire Interface which couple into the "PGA309 PC Interface Board" Two-Wire Interface used to communicate with the ADS1100. Since the Two-Wire Interface does not use a low impedance pull-up (instead a 4.7kΩ resistor) these negative going transients are sufficient to inject random valid low-going edges into the Two-Wire Interface on the "PGA309 PC Interface and the larger the injected negative transients become. The Two-Wire Interface on the PGA309 was intended for local communication between a resident EEPROM or microcontroller and the PGA309. It is recommended that for Temperature calibration setups, as illustrated in Figure 46, that the One-Wire Interface (PRG) be used for reliable communications.

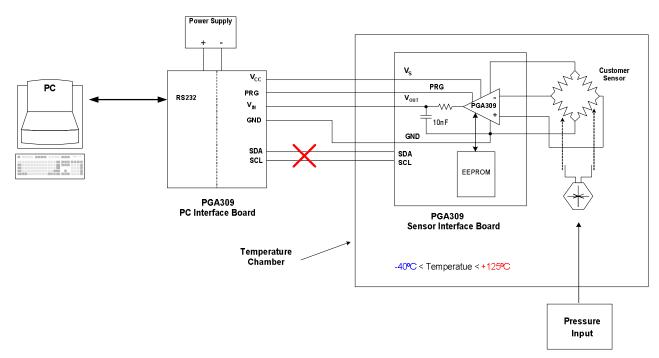


Figure 46: Use One-Wire (PRG) Interface for Temperature Calibration



#### 10.2 4-Wire Sensor Modules and One-Wire Interface (PRG):

When using the PGA309 in a 4-Wire ( $V_s$ , PRG,  $V_{OUT}$ , GND) Sensor Module Application, as shown in Figure 47, there is an optimum way to deal with the PRG pin. For minimum component count you can put the required pull-up resistor, Rp, for One-Wire (PRG) communication on the PGA309 PC Interface Board. After Sensor Calibration is complete a final write to the EEPROM is done. During this final write to the EEPROM the PGA309 One-Wire interface, PRG pin, can be configured to be disabled. This means that it can now float without any adverse consequences such as high current draw through  $V_s$  or erroneous digital communication due to transients on the PRG pin.

To disable the One-Wire Interface set the OWD bit to '1' during the final EEPROM program write. The OWD (One Wire Disable) bit is located in Register 4 [Bit15]. After this "final" programming all is not lost, as any power-up sequence will allow the One-Wire Interface (PRG pin) control, if communication is initiated within 25ms of the application of power to the PGA309.

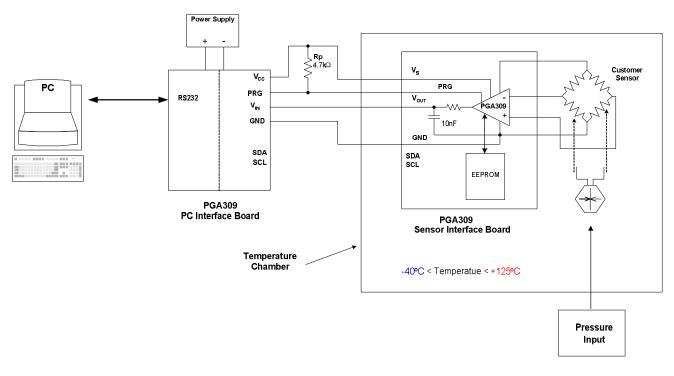


Figure 47: PGA309 4-Wire Sensor Module Application



# 10.3 Regional Settings Problem:

On some European Computers when the PGA309DK Control Software is started an error is reported as illustrated in Figure 48.



# Figure 48: Run-time error from PGA309DK Software.

#### Cause:

This error [Runtime Error "13" – Type Mismatch Error] is usually caused by the decimal representation of non-English language computers which use a "," (comma) instead of a "." (period) for the decimal separator. [i.e. 100.89 represented as 100,89]

#### Solution:

The solution involves regional settings changes in two different places on the User's Computer. : For Windows XP or NT you must be logged on as an Administrator or a Member of the Administrators Group in order to complete this procedure.

*Step1:* From the Windows "Start" Menu select and click on "Control Panel" See Figure 49. The Control Panel will open in a new window as shown in Figure 50.



Neighborhood Power	Obtions
a0867024	
MSN Explorer MSN Explorer Windows Explorer Launch Microsoft Outlook PGA309 DK March Tina	Wy Documents       7         My Recent Documents       8         Favorites       9         My Computer       9         My Network Places       9
Image: Shortcut to Visio.exe         Shortcut to EXCEL.EXE         Shortcut to WINWORD.EXE         Notepad         Adobe Reader 6.0         Paint         ESP 2         Shortcut to POWERPNT.EXE	Control Panel  Set Program Access and Defaults  Connect To Printers and Faxes  Help and Support Search  Run
Undock Compu	iter 💋 Log Off 🔟 Shut Down

Figure 49: "Control Panel" Select

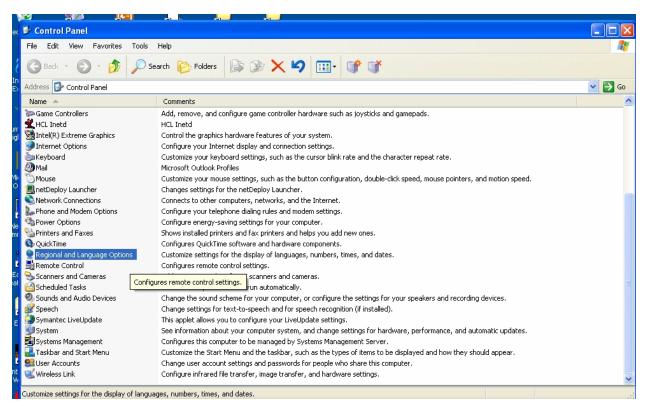


Figure 50: "Control Panel"



*Step 2:* As in Figure 50, select and click on "Regional and Language Options" in the "Control Panel" window. A new pop-up window, "Regional and Language Options" will appear as in Figure 51.

gional and L	anguage Options
egional Options	Languages Advanced
- Standards and	d formats
This option a dates, and tin	ifects how some programs format numbers, currencies, ne.
Select an iter your own forn	n to match its preferences, or click Customize to choose nats:
Polish	Customize
Samples	
Number:	123 456 789,00
Currency:	123 456 789,00 zł
Time:	16:08:31
Short date:	2004-06-21
Long date:	21 czerwca 2004
Location	
	ces provide you with local information, such as news and ct your present location:
United State	s 💌
	OK Cancel Apply

Figure 51: "Regional and Language Options" pop-up window

*Step 4:* Click on the "Advanced" tab in the "Regional and Language Options" pop-up window. The pop-up window will change as shown in Figure 52.

1	Regional and Language Options	
эг	Regional Options Languages Advanced	re su
tc E	Language for non-Unicode programs This system setting enables non-Unicode programs to display menus	em. has.
ď	and dialogs in their native language. It does not affect Unicode programs, but it does apply to all users of this computer.	r blir
	Select a language to match the language version of the non-Unicode programs you want to use:	onfiç
.с С	Polish	erne
n		tting
)p a	Code page conversion tables	bu ac
ne	🔽 10000 (MAC - Roman)	nent
ы	<ul> <li>✓ 10001 (MAC - Japanese)</li> <li>✓ 10002 (MAC - Traditional Chinese Big5)</li> </ul>	bers
C S	I 10002 (MAC - I raditional Chinese Bigo) I 10003 (MAC - Korean)	
эс	10004 (MAC - Arabic)	
ar	10005 (MAC - Hebrew)	figur
эс	Default user account settings	ecog settir
: 1	Apply all settings to the current user account and to the default user profile	iangi Mar
а		he ty
20 - 1		ople • hard
_	OK Cancel Apply	Idru

Figure 52: "Advanced" tab view in "Regional and Language Options" pop-up window



*Step 5:* In the "Language for non-Unicode Programs" section click on the drop-down menu arrow and select "English (United States)" as shown in Figure 53. If your computer is already configured for "English (United States)" as the "Language for non-Unicode Programs" skip to Step 7.

'S	Regi	ional and Language Options ?	×
1	Be	gional Options Languages Advanced	
1			
bd	L CL	Language for non-Unicode programs	1
		This system setting enables non-Unicode programs to display menus and dialogs in their native language. It does not affect Unicode programs, but it does apply to all users of this computer.	
ih IN		Select a language to match the language version of the non-Unicode programs you want to use:	
		Polish	
		English (South Africa)	
I.I		English (Trinidad)	
le		English (United Kingdom)	
		English (United States) English (Zimbabwe)	
		Estonian	
		Faeroese	
ų		Finnish	
hC		French (Belgium)	
		French (Canada)	
		French (France)	
		French (Luxembourg)	
1		French (Monaco)	
с	6	French (Switzerland) FYBO Macedonian	
1		Galician	
		German (Austria)	
		German (Germany)	
		German (Liechtenstein)	
1		German (Luxembourg)	- 1
		German (Switzerland)	
		Greek	
		Hungarian	
	X	Icelandic	
Ľ		Indonesian Italian (Italy)	
hc	ortcut	Italian (Kaly) Italian (Switzerland)	
X	LEL.EX	Japanese	
Γ.	10000	Kazakh	
		Korean 💌	

# Figure 53: "Language for non-Unicode Programs" selection

*Step 6:* Now click on "Apply". You will be queried to restart your computer. Restart your computer and repeat Step 1 and Step 2 above and then continue on with Step 7.

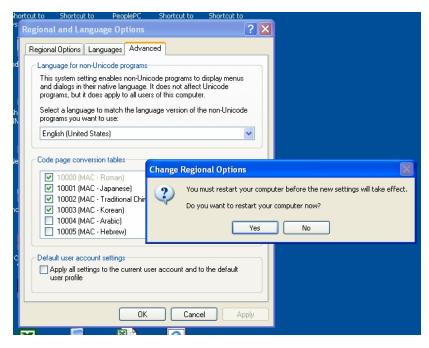


Figure 54: Restart Computer



*Step 7:* In the "Regional and Language Options pop-up window click on the "Regional Options" tab as shown in Figure 55.

1	Regional and Language (	Options	? 🛛	$\vdash$
эг	Regional Options Language	es Advanced		e su
tc	Standards and formats			
E : (	This option affects how so dates, and time.	ome programs format numb	pers, currencies,	em. ngs.
ď	Select an item to match its your own formats:	s preferences, or click Cus	stomize to choose	r blir
25	Polish	×	Customize	onfi
-9 20	Samples			erne
	Number: 123 456 7	89,00		ttinç
)p a	Currency: 123 456 7	'89,00 zł		pu a
he	Time: 16:08:31			nent
	Short date: 2004-06-2	1		bers
s	Long date: 21 czerwc	a 2004		
эс				
ar	- Location			figur ecoq
эс	To help services provide y weather, select your prese	you with local information, ent location:	such as news and	settii iang
: P	United States		~	Mar
а				he t
20 : 1				ople hard
-		OK Car	Apply	aru
et tri	ings for the display of languages	s, numbers, unies, and ua	ices.	

# Figure 55: "Regional and Language Options" pop-up window – "Regional Options" tab

*Step 8:* Click on the "Customize" Tab in the "Regional Options" tab of the "Regional Language Options" popup window as shown in Figure 56.

	ortcut t	o Shortcut to	PeoplePC	Shortcut to	Shortcut to	_
VS	Regio	onal and Langua	ge Options			? 🗙
1	Bec	ional Options Lang	uages Advand	and		
Mod		itandards and formats	-	260		
mod		Customize Regio				2
		Numbers Currence	xy Time Da	ite		
Sh WIN		Sample				
		Positive: 123 4	56 789,00	Negative:	-123 456 789,00	)
Ne						
		Decimal symb	ool:			~
		No. of digits a	after decimal:	2		~
Wind		Digit grouping	; symbol:			~
		Digit grouping	j:	123 456 7	89	~
		Negative sigr	n symbol:	•		~
d		Negative nun	nber format:	-1,1		~
		Display leadir	ig zeros:	0,7		~
		List separator	:	;		~
		Measurement	: system:	Metric		~
	X	Digit substitut	ion:	None		~
	ortout CEL.E			ОК	Cancel	Apply
	20000					

Figure 56: "Customize Regional Options" pop-up window



**Step 6:** In the "Customize Regional Options" pop-up window, as shown in Figure 56, under the "Decimal symbol" option select "." from the drop-down menu as shown in Figure 57. Click on "OK" in the "Customize Regional Options" window which will return you to the "Regional and Language Options Window as shown in Figure 58. Notice that under the "Number" section in this window the decimal separator of the number displayed is shown as a "." (period) instead of it original setting in Figure 55 of a "," (comma).

hortcut	to Shortcut to PeoplePC	Shortcut to Shortcut to	
' <sup>s</sup> Regi	onal and Language Options	? 🗙	
Re	gional Options Languages Adva	anced	
d in	Standards and formats		
	Customize Regional Option	15 🥐 🔀	
	Numbers Currency Time	Date	
ih i	Sample		
IN I	Positive: 123 456 789,00	Negative: -123 456 789,00	
la			
	Decimal symbol:		
	No. of digits after decimal:	,	
	Digit grouping symbol:	~	
<b>`</b>	Digit grouping:	123 456 789 💌	
	Negative sign symbol:	•	
d	Negative number format:	-1,1 💌	
1	Display leading zeros:	0,7	
	List separator:	;	
	Measurement system:	Metric	
X	Digit substitution:	None	
hortcut			
XCEL.E	L	OK Cancel Apply	J
49939			-

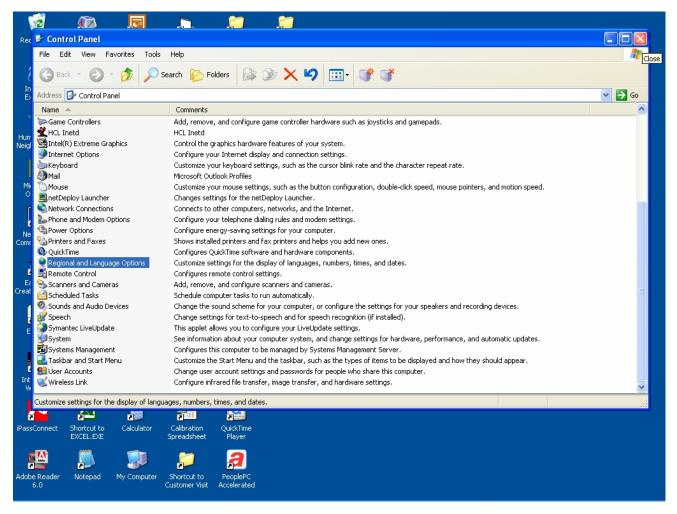
Figure 57: "Decimal symbol" select in the "Customize Regional Options" pop-up window

	rtcut to Shorta	ut to Peoplef	C Shortcut	to Shortcut to											
's	Regional and L	anguage Optio	ns	? 🛛											
	Regional Options	Languagee III	dvanced												
bd	Standards and														
	dates, and tin	ffects how some pr ne.	ograms format nu	mbers, currencies,											
Į	Select an item to match its preferences, or click Customize to choose your own formats:														
n IN	Polish			Customize											
	Samples														
1	Number: 123 456 789.00														
le	Currency: 123 456 789,00 zł														
	Time: 16:29:20														
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	Location														
ç		ces provide you wi ct your present loc		n, such as news and											
	United State	s		~											
			ок с	ancel Apply											

Figure 58: Return to the "Regional and Language Options" window after "Decimal symbol" changes



*Step 7:* In the "Regional and Language Options" window, as in Figure 58, click on "OK". This will close all pop-windows and you will be back at the main "Control Panel" window on the desktop. Close this window by clicking on the "X" in the upper right hand corner of this window as in Figure 59.

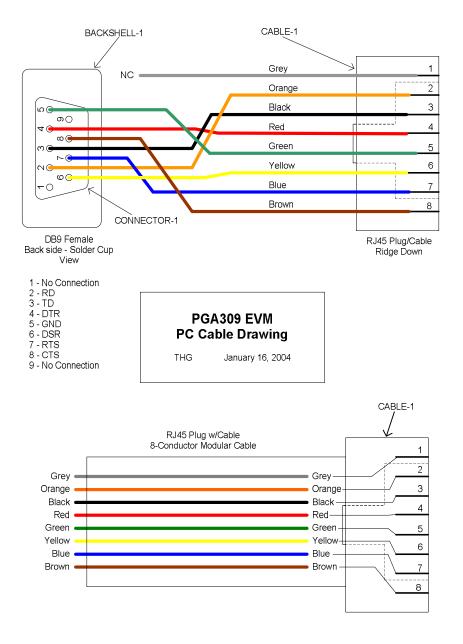


# Figure 59: "Control Panel" window

Step 8: Start the PGA309DK Control Software. Now all features of PGA309DK Software should be working correctly.



# 11.0 PGA309EVM PC Cable Drawing



Burr-Brown Products from Texas Instruments

# 12.0 PGA309EVM External EEPROM Settings for Functional Test

B-Bit EEPROM Lo	ad >>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>	>>>>>>					L	ocation '1'							Loca	ion '0'				
GA309 External	EEPROM - First Part	(Configuration Data)		8	4	2	1	8	4	2	1	8	4	2	1	8	4	2	1	
							Ū	Ipper Byte							Lowe	r Byte				
External EEPROM	PGA309	PGA309																		
Address	Internal Register	Internal Address																		
(Decimal)	Address	Description	Data	D15	D14	D13	D12	D11	D10	D9	D8	D7	D6	D5	D4	D3	D2	D1	DO	Hex Eq
1/0	Address	Description	Programmed Flag Value	015	014	013			DIU	Da	00	07	00	05	04	03	02		00	Hex Eq
MSB/LSB			Must be as Shown	0	1	0	1	0	1	0	0	0	1	0	0	1	0	0	1	5449
WIGD/LGD			Must be as Shown			0		0	1	0	0	0	- 1		0		0	+		5445
3/2			Unused	<u> </u>														<u> </u>		
MSB/LSB			Set to Zero	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0000
5/4			Unused		- U				0			-	0	L .			Ŭ	<b>—</b>		0000
MSB/LSB			Set to Zero	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0000
1100/200				-	Ű	Ů			Ű	Ű		-	Ŭ	- °	<u> </u>		Ű			
7/6	00011						<u> </u>				<u> </u>							<u> </u>		
MSB/LSB	(Register 3)	Reference Control & Linearization		RFB	RFB	RFB	RFB	EXS	EXEN	RS	REN	LD7	LD6	LD5	LD4	LD3	LD2	LD1	LD0	
7/6	( - 5			0	0	0	0	0	1	0	1	0	0	0	0	0	0	0	0	0500
					l Č						· · ·		0					<b>—</b>		3000
9/8	00100	PGA Coarse Offset & Gain / Output Amp		<u> </u>	1													<u> </u>		
MSB/LSB	(Register 4)	Gain		OWD	GO2	GO1	GO0	GI3	GI2	GI1	GI0	RFB	RFB	RFB	OS4	OS3	OS2	OS1	OS0	
9/8	(			0	0	0	1	0	1	1	0	0	0	0	1	0	0	0	1	1611
0,0					Ť	Ť	<u> </u>				Ť	Ť	v	L .	<u> </u>	Ť	Ť	Ť		
11/10	00101	PGA Configuration & Over/Under Scale		<u> </u>		CLK	CLK											<u> </u>		
MSB/LSB		Limit		RFB	RFB	CFG1	CFG0	EXTEN	INTEN	EXTPOL	INTPOL	RFB	OU EN	HL2	HL1		LL2	LL1	LLO	
	(Register 5)												1 1			HLO				0.4.47
11/10				0	0	0	0	1	0	1	0	0	1	0	0	0	1	1	1	0A47
10/10	00110													-				<u> </u>		
13/12 MSB/LSB	00110 (Pagister 6)	Tomporaturo ADC Control		RFB	RFB	ADC2X	ADCS	ISEN	CEN	TEN	AREN	RV1	RV0	M1	мо	G1	G0	R1	R0	
	(Register 6)	Temperature ADC Control																		1000
13/12				0	0	0	0	0	1	1	0	0	0	0	0	0	0	1	1	1603
15/11																		+	SUM =	(8FA4)
15/14		FFFF - sum(Hex Eq of each location 1/0	Chaskaum1		_			_	~	_							1			7055
MSB/LSB		thru13/12) truncated above 16 bits	Checksum1	1	0	0	0	0	0	0	0	0	1	1	0	1	1	0	0	705B
				<u> </u>														<u> </u>		
			L								L									
8-Bit EEPROM Load >>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>				Location '1'						Location '0'										
PGA309 External	EEPROM - Second Pa	art (Temperature Coefficients)		8	4	2	1	8	4	2	1	8	4	2	1	8	4	2	1	
				_			u	Ipper Byte							Lowe	r Byte				
External																				
EEPROM																				
Address																				
(Decimal)			Data	D15	D14	D13	D12	D11	D10	D9	D8	D7	D6	D5	D4	D3	D2	D1	D0	Hex Eq
17/16			T0 (Temperature Index Value																	
MSB/LSB			for Temp <u>&lt;</u> T0)	0	0	0	0	1	0	0	0	0	0	0	0	0	0	0	0	0800
19/18			Z0 (Zero DAC value for Temp									T								
MSB/LSB			<u>&lt;</u> T0)	0	0	0	0	0	1	1	0	0	1	0	0	0	0	0	0	0640
21/20			G0 (Gain DAC value for																	
MSB/LSB			Temp <u>&lt;</u> T0)	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	FFFF
23/22			T <sub>END</sub>																	
MSB/LSB			(End of Look-up Table)	0	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	7FFF
25/24			ZM <sub>END</sub>									T								
23/24	1		(End of Look-up Table)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0000
MSB/LSB																				
																			SUM =	(18E3E)
MSB/LSB																		—	SUM =	(18E3E)
		FFFF - sum(Hex Eq of each location 17/16 thru 25/24) truncated above 16 bits																<u> </u>	SUM =	(18E3E)



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